

The 20th Korea-U.S. Forum on Nanotechnology

Group II: Energy-efficient for AI & Neuromorphic System

September 14, 2026 (Monday), Mckimmon Center

Linearly programmable memristors for neuromorphic computing hardware

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Seoul National University (SNU)



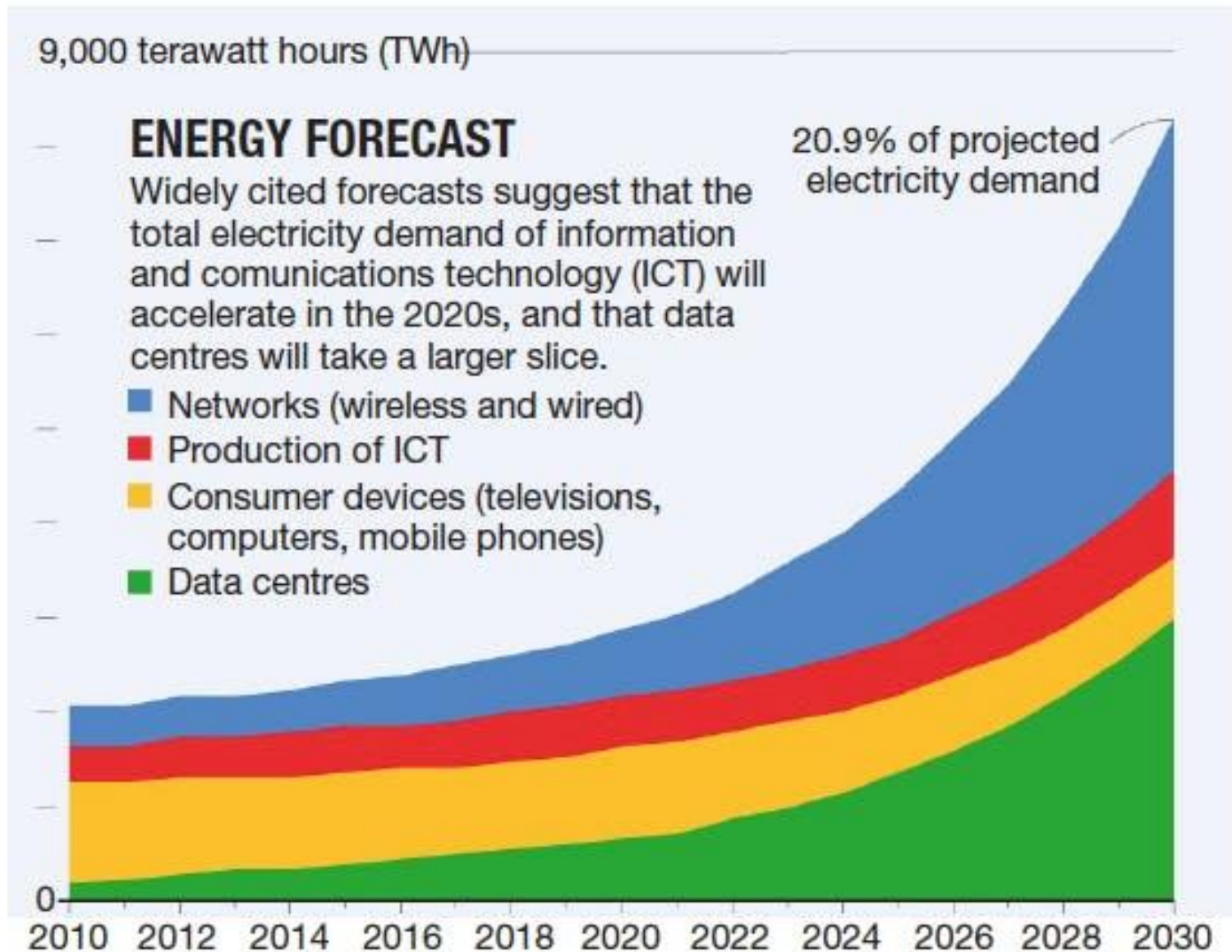
$$\sqrt{\epsilon_r \mu_r} \sqrt{\epsilon_r \mu_r} V dt/dI, F/a \quad k \log \Omega \quad mc^2, E \times H \quad PV/RT \quad H - PV$$

Current AI hardware is not efficient energetically



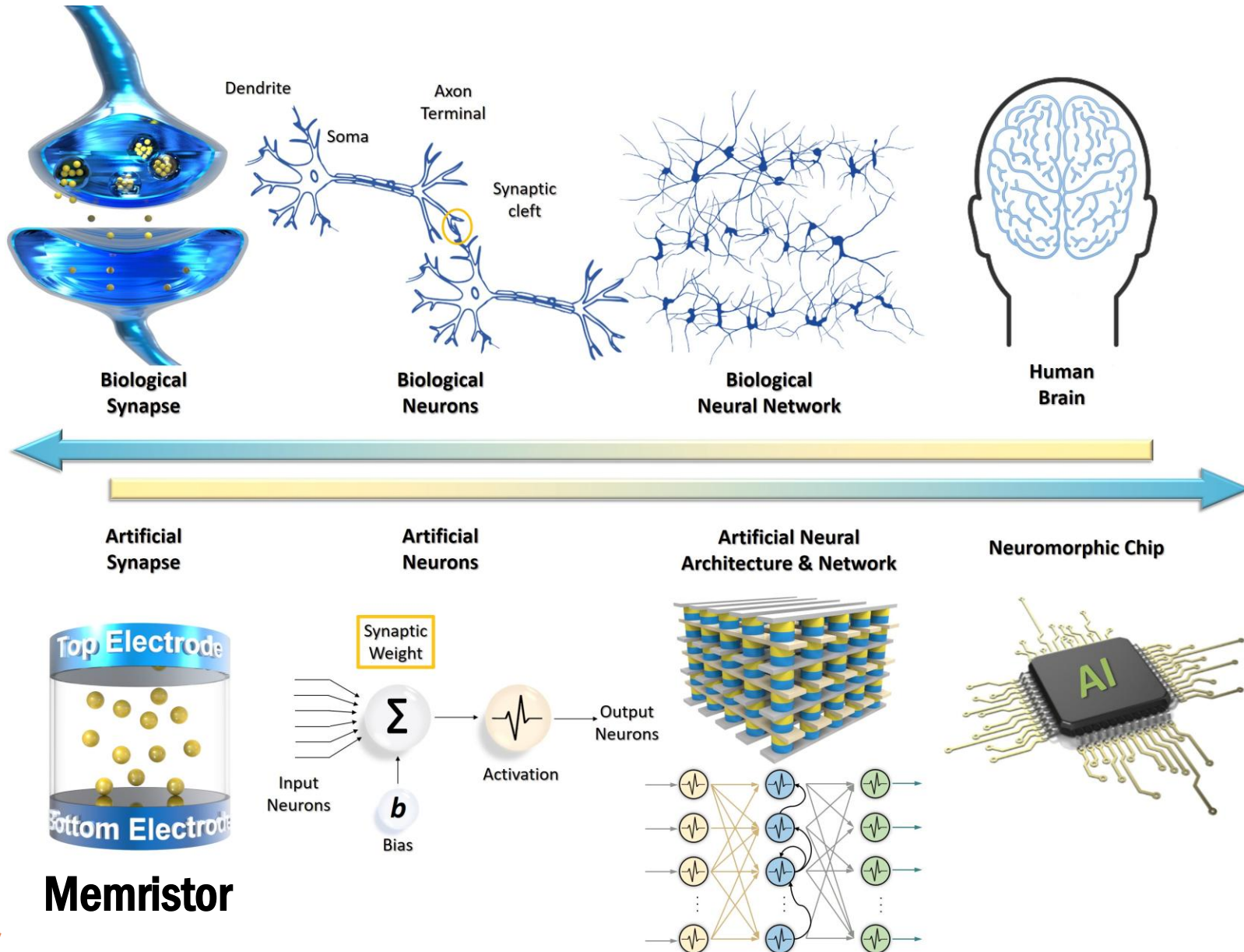
https://www.chosun.com/opinion/specialist_column/2021/11/15/MIYL74YOFFFFXA5MJJXY2T722A/

Current AI hardware is not efficient energetically



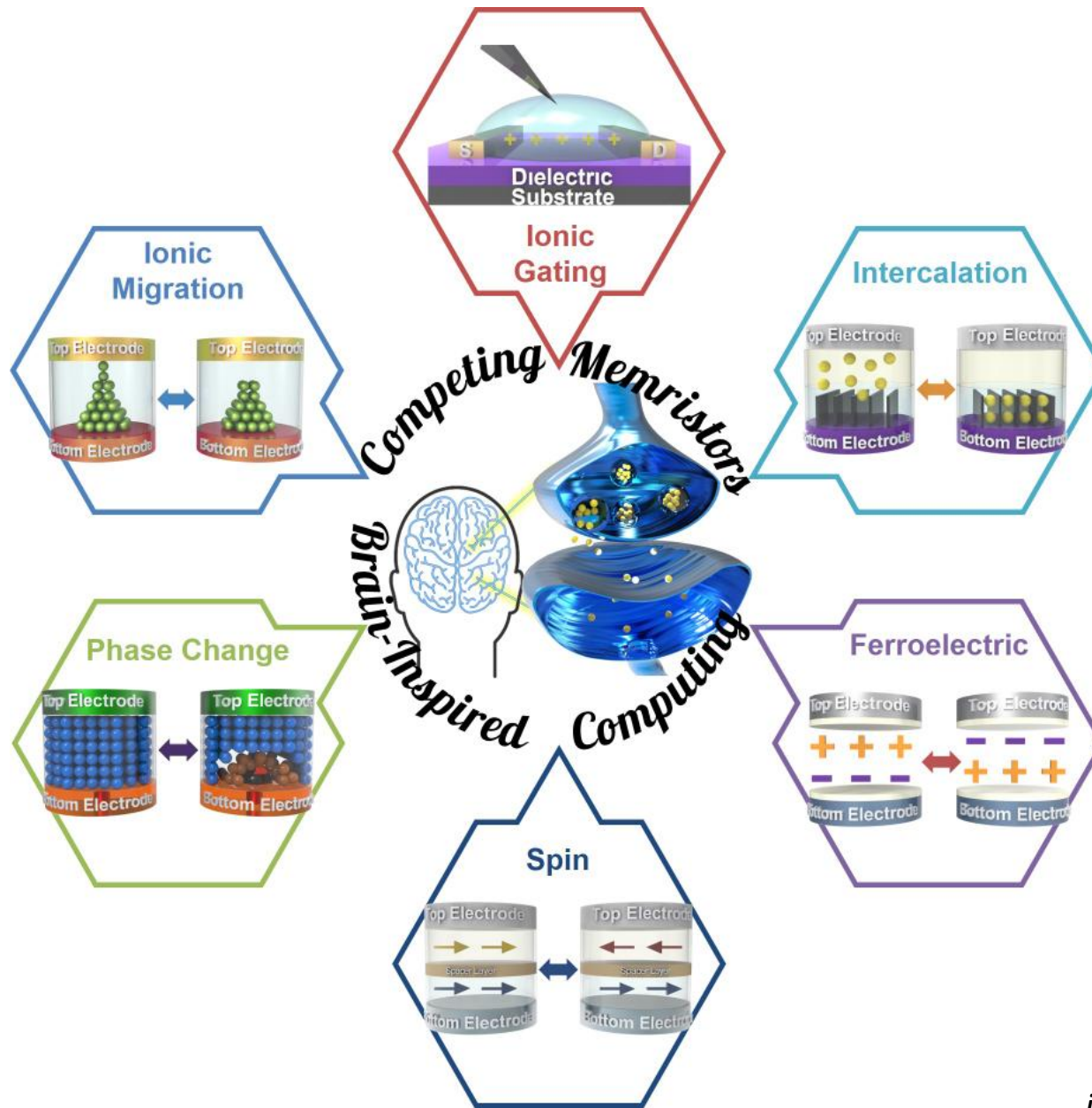
Source: *Nature* **561**, 163-166 (2018)

Comparing biological & artificial processor

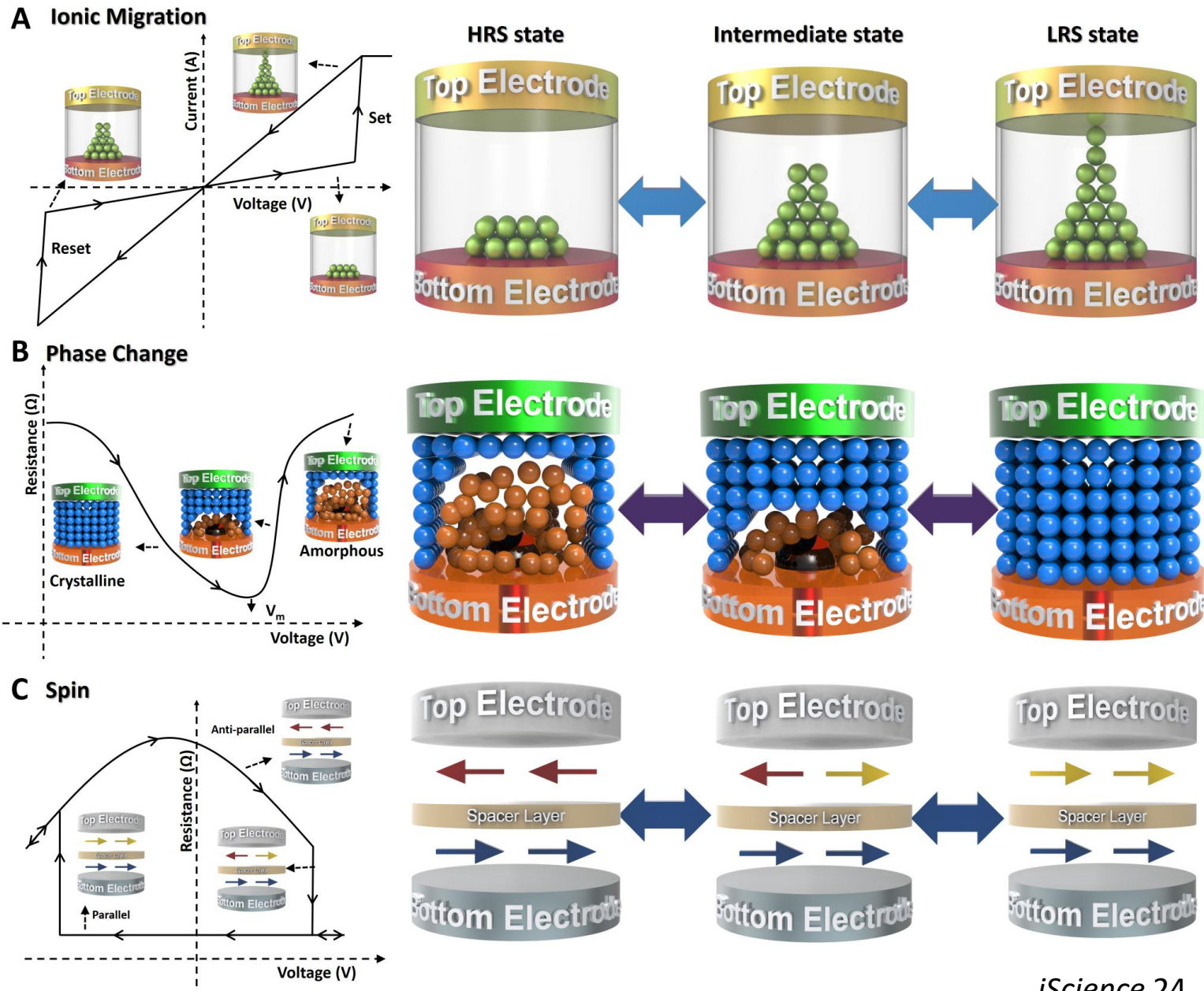


Dr. Seung Ju Kim

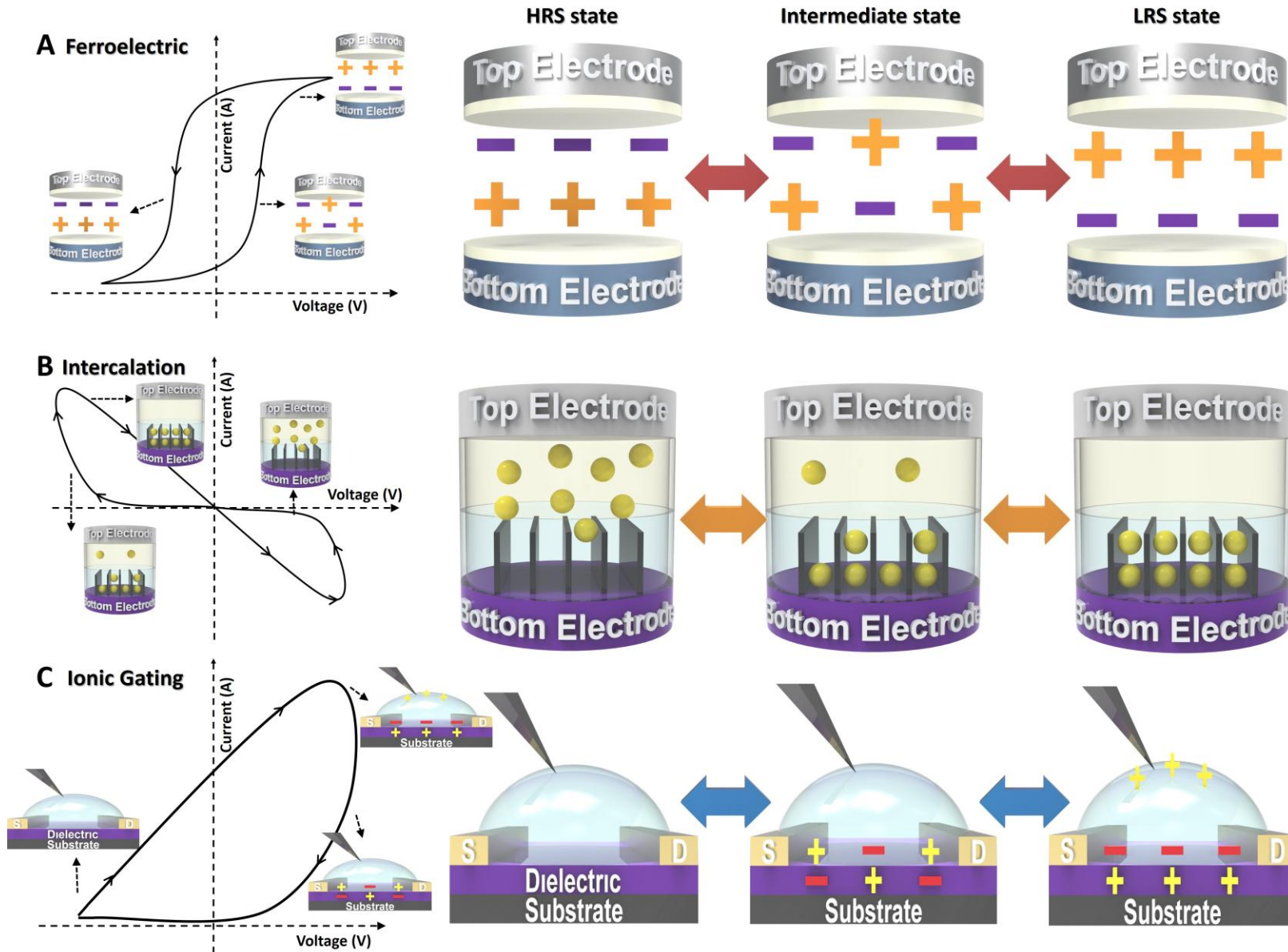
Various memristors for neuromorphic computing



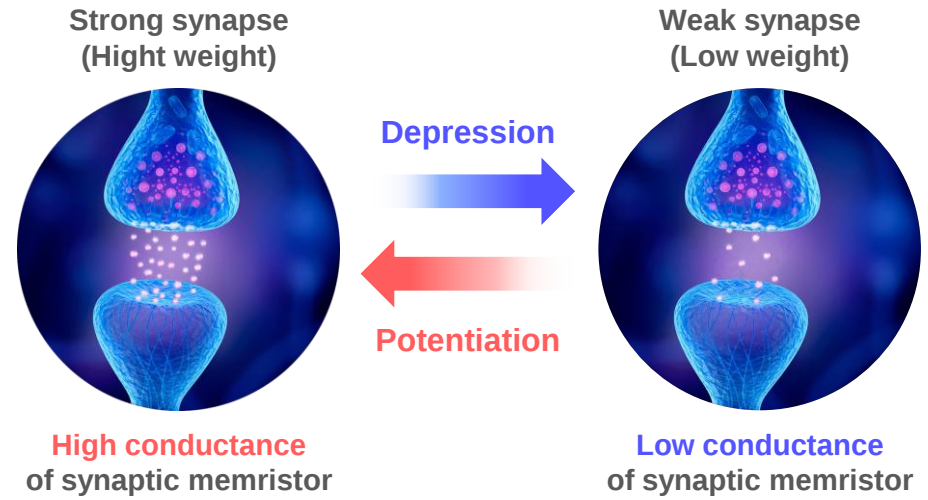
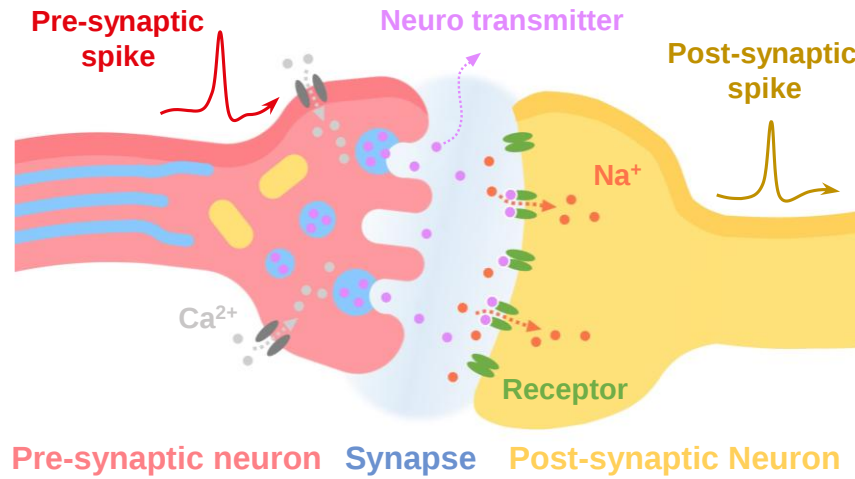
Resistive switching (ionic migration), phase change, spin



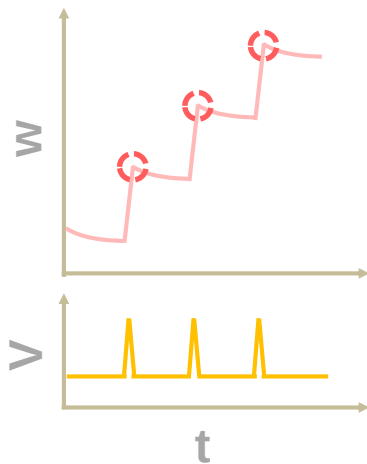
Ferroelectric, intercalation, ionic gating



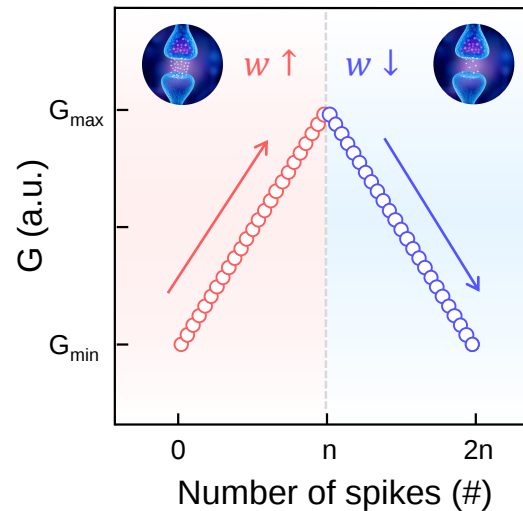
Synaptic weight of artificial synapses



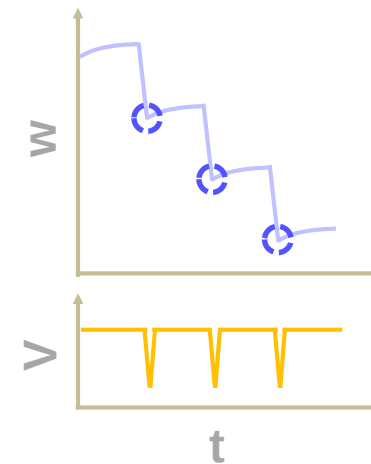
Potentiation



Conductance **increased**



Depression

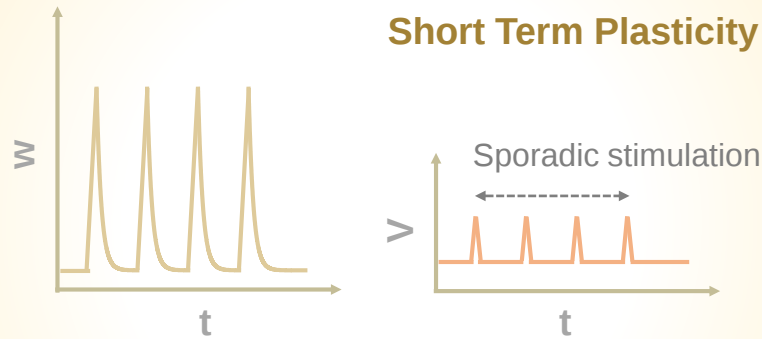


Conductance **decreased**



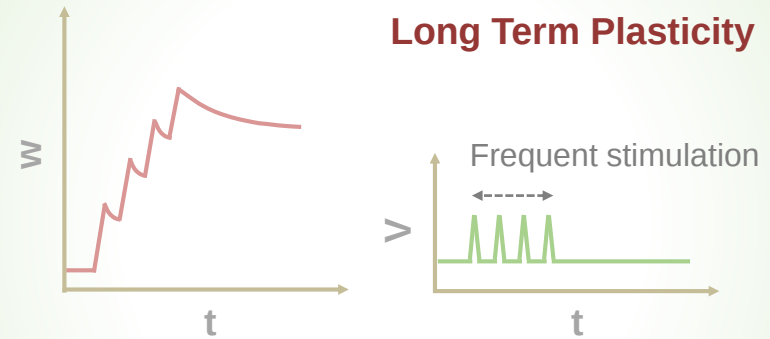
Spike-dependent weight modification

Short Term Plasticity



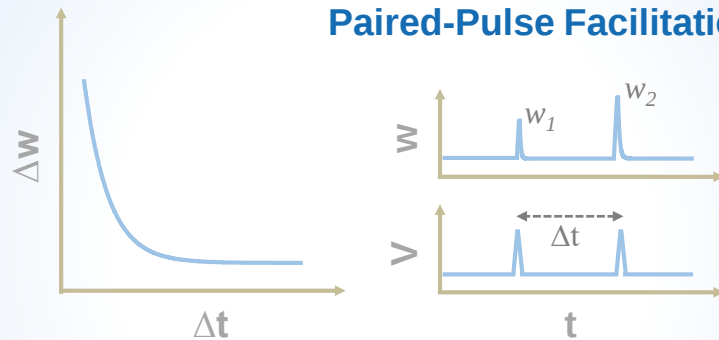
“A transient deformation in synaptic efficacy.”

Long Term Plasticity



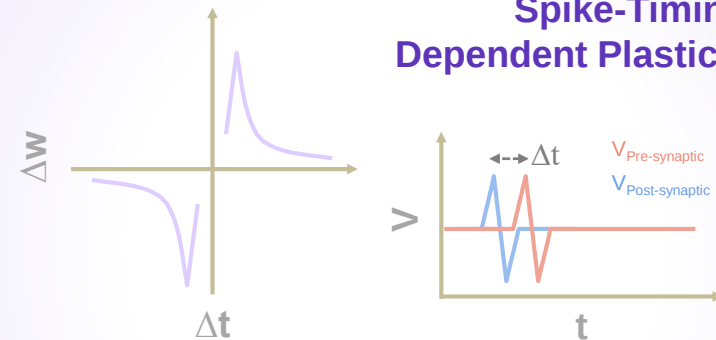
“A long-lasting change in synaptic connection.”

Paired-Pulse Facilitation



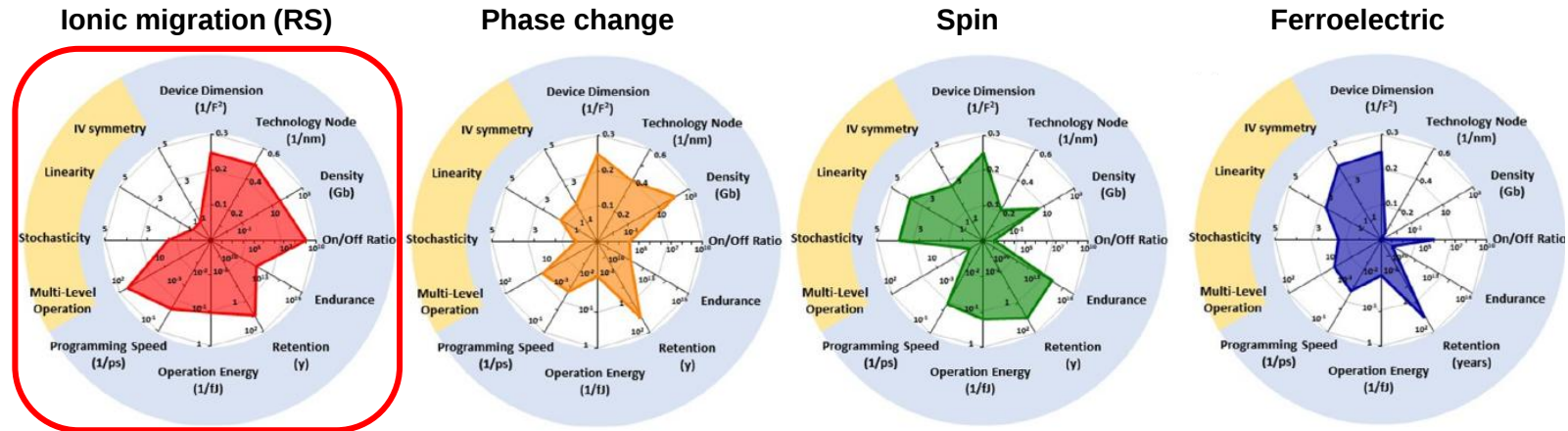
“Amplification of the secondary neural signal due to the immediately preceding impulse.”

Spike-Timing-Dependent Plasticity



“A weight specialization based on a firing order of pre-and post-synaptic neurons.”

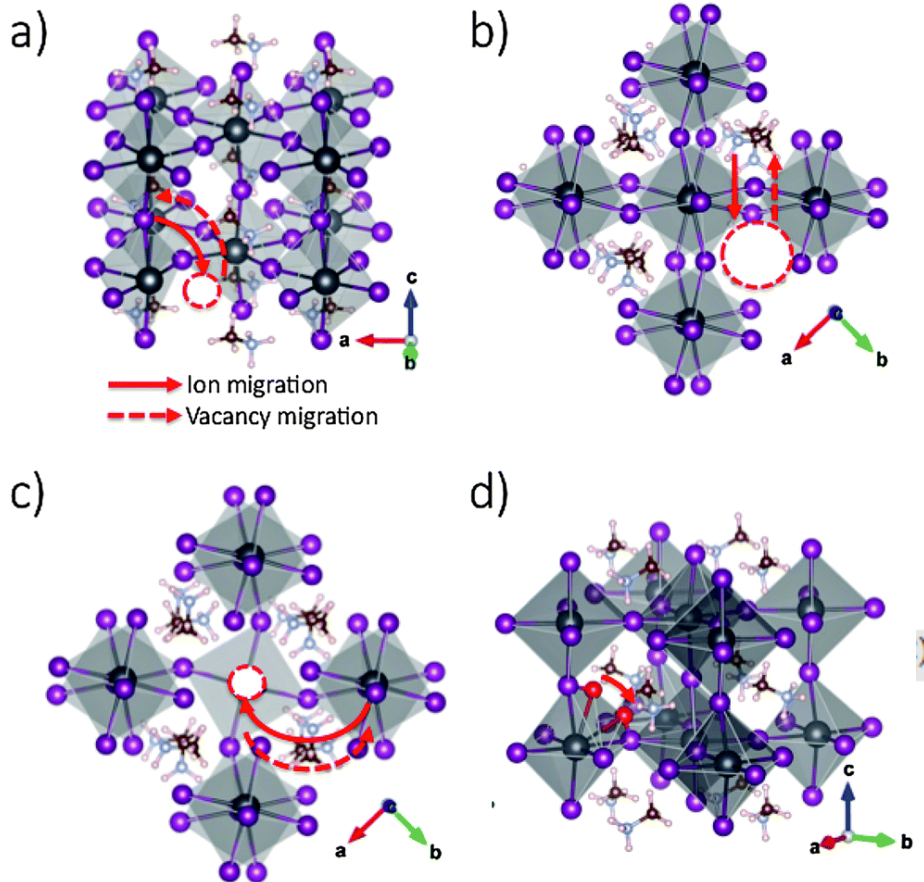
Competing memristors



Technology	CMOS-based		Memristor-based			
	Flash	DRAM	Resistive switching	Phase change	Spintronics	Ferroelectric
Device dimension	$4F^2$	$6F^2$	$4F^{2[95]}$	$4F^{2[126]}$	$4F^{2[127]}$	$4F^{2[128]}$
Feature size (F)	15 nm	17.5 nm	2 nm ^[95]	2.5 nm ^[126]	5 nm ^[129]	20 nm ^[24]
Density	512 GB	32 GB	32 GB ^[130]	128 GB ^[50]	4 GB ^[131]	—
On/off ratio	—	—	$10^{8[121]}$	$10^{3[18]}$	$10^{[22]}$	$10^{4[132]}$
Endurance (cycles)	10^5	10^{15}	$10^{12[27]}$	$10^{11[133]}$	$10^{14[125]}$	$10^{9[134]}$
Retention	>10 y	64 ms	>10 y ^[31]	>10 y ^[122]	>10 y ^[21]	>10 y ^[135]
Operation energy	160 pJ	—	8 fJ ^[136]	100 fJ ^[137]	6 fJ ^[124]	100 fJ ^[138]
Programming speed	80 μ s	10 ns	85 ps ^[139]	700 ps ^[122]	190 ps ^[140]	600 ps ^[141]
Multi-level operation	—	—	64 ^[142]	16 ^[143]	2 ^[144]	10 ^[25]
Variability	—	—	Medium	Medium	High	Low
Linearity	—	—	Low	Medium–low	High	Medium–low
Research matured	—	—	2 Mb array pattern recognition	165 k network MNIST	Single device	Single device
Pros	High density	Fast speed	Gradual conductance change	High density	Reliability	CMOS compatible
Cons	Individual inaccessible	Volatility	Nonlinearity	Conductance drift asymmetric	Less multi-state narrow dynamic range	Low density

Defect migration in halide perovskites

- ✓ Diffusion paths for (a) V_I , (b) V_{MA} , (c) V_{Pb} and (d) I_i defects

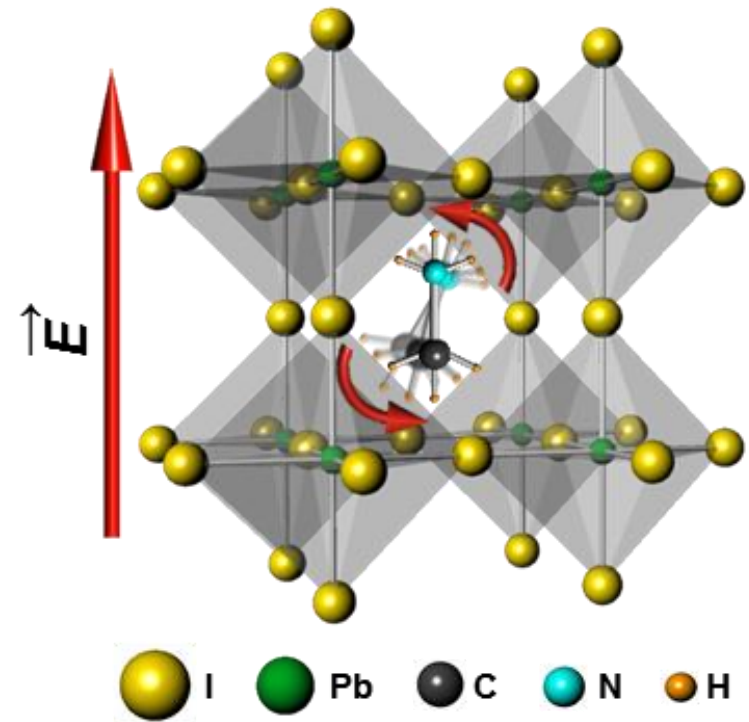


Azpiroz et al., *Energy Environ. Sci.*, 2015, 8, 2118-2127

Hysteretic I - V characteristics
: ion migration, structural flexibility

- ✓ Structural flexibility

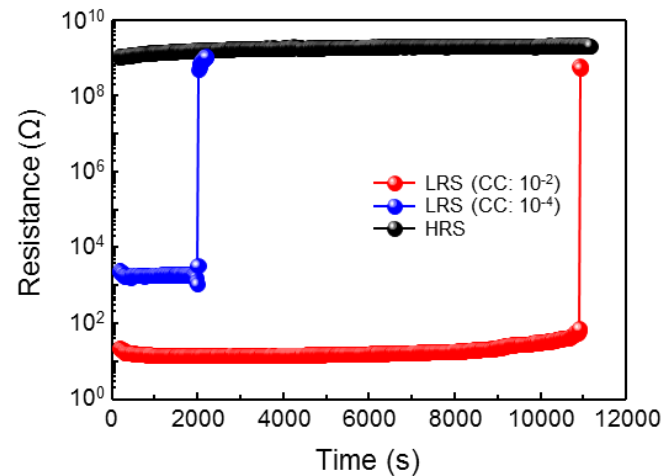
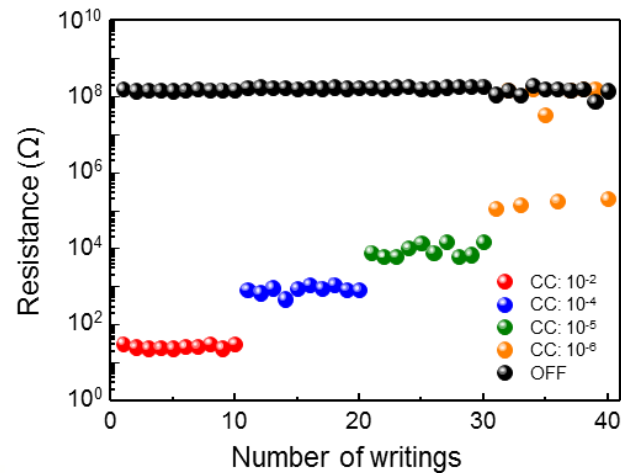
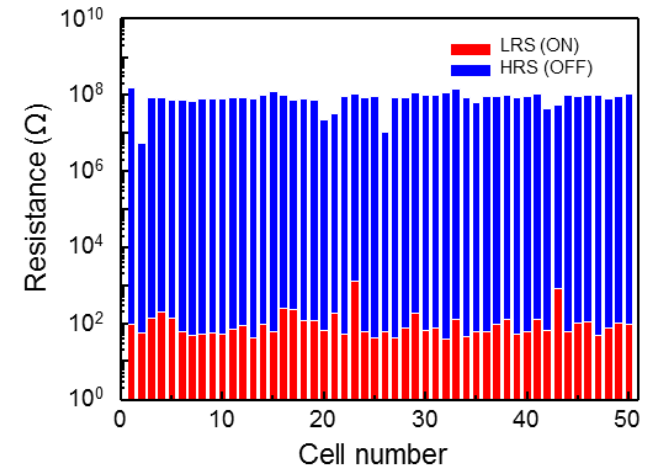
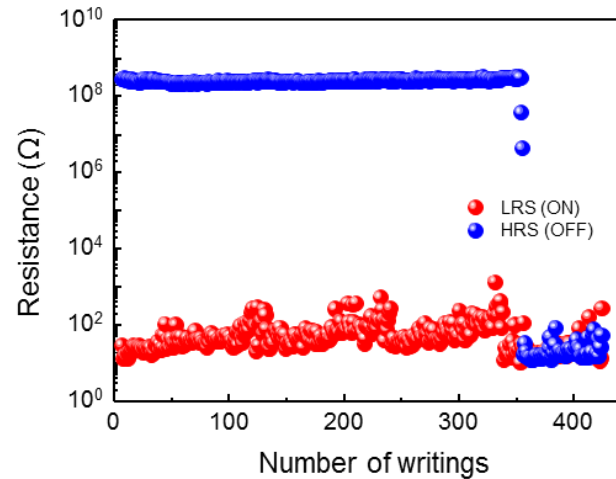
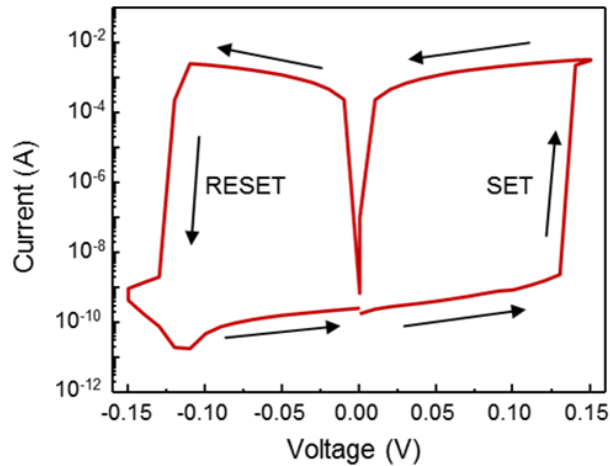
- MA cation tilted in equilibrium state (30°)
- MA cation is aligned by E-field
- Migration of ionic species easier



A-site molecular rotational motion in a unit cell of $\text{CH}_3\text{NH}_3\text{PbI}_3$.

Application to microelectronics such as resistive switching memories

Resistive switching in Ag/MAPI₃/Pt



• Ultra-low voltage resistive switching

- Only ± 0.15 V of operation voltage (3.25×10^3 V/cm)
- High ON/OFF ratio (Avg. 1.12×10^6)
- Uniform resistive switching behavior
- Multi-level switching available
- 350 cycles endurance and 11000 s retention

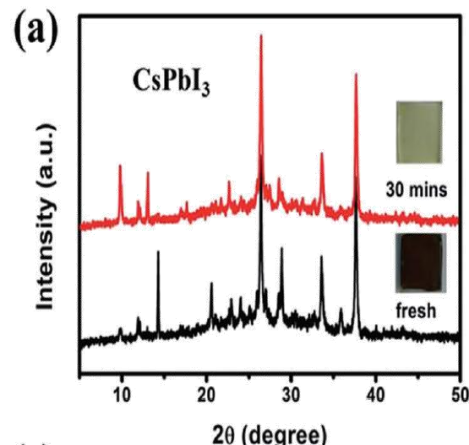
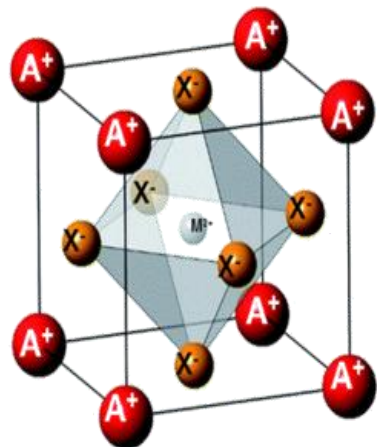


Dr. Jaeho Choi

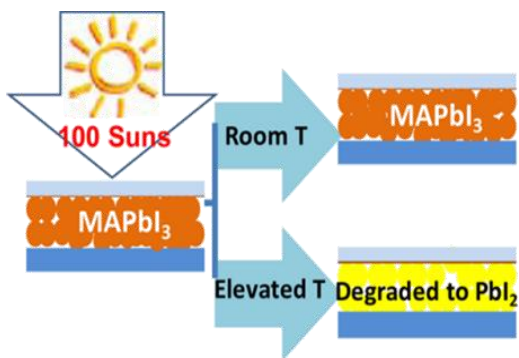
Adv. Mater. **28**, 6562-6567 (2016)

Challenges of 3D halide perovskite as artificial synapses

Heat & Moisture Instability of 3D Halide Perovskites



Energy Environ. Sci., 2018, 11, 234–242

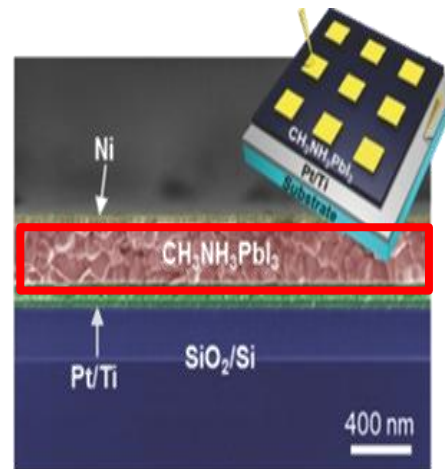


ChemSusChem 2019,12,1560–1575

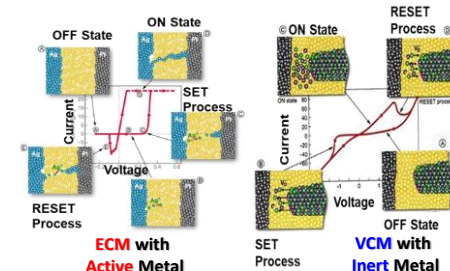
3D Organo-Halide Perovskite is an **unstable** phase, which is **vulnerable** to heat & moisture in the air, making it difficult to commercialize



Polycrystalline nature causes non-linearity



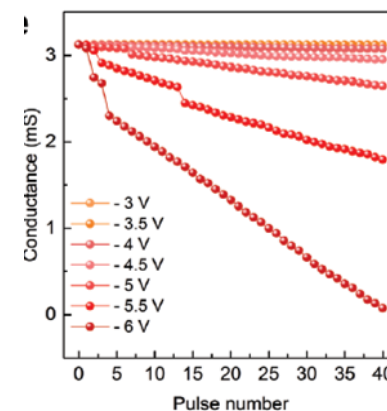
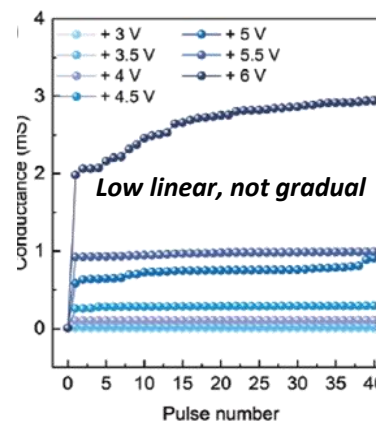
Adv. Mater. 2016, 28, 6562–6567



R. Waser, *Nanoelectronics and Information Technology* 3rd edition, Wiley-VCH, (2012)

Charged ion migration controlling is a key for the memristor.
Grain shape and size are major factors.

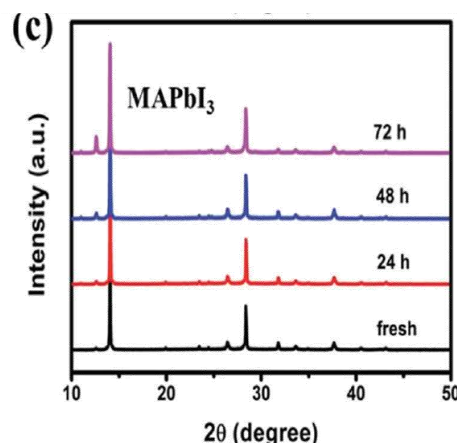
Al / POT2T / MAPbBr₃(3D) / PEDOT:PSS / ITO



Adv. Mater. 2021, 33, 2007851

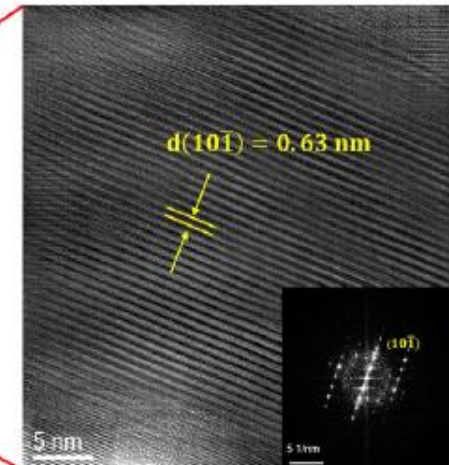
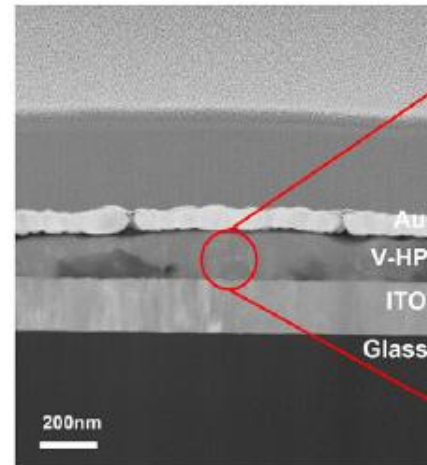
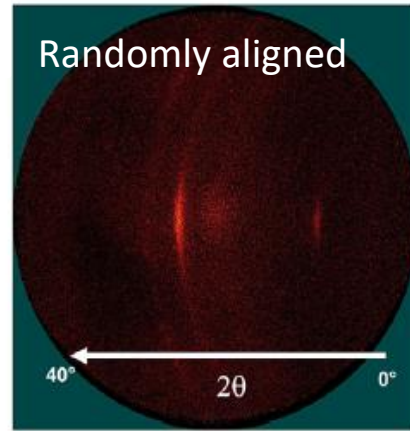
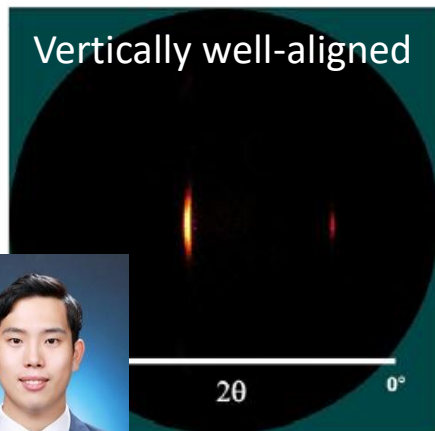
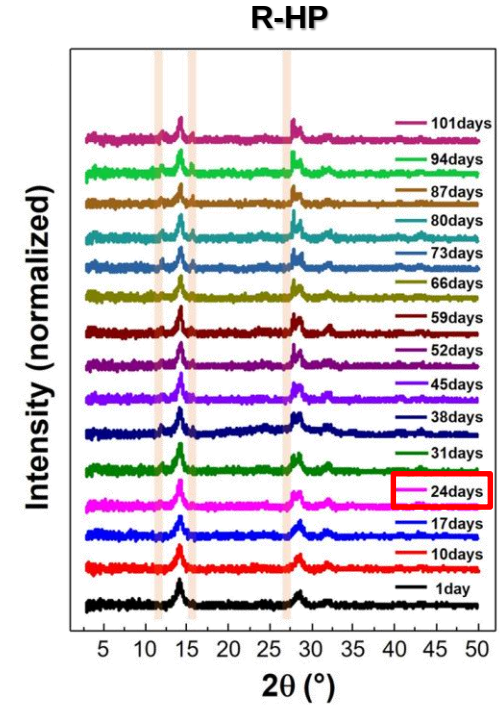
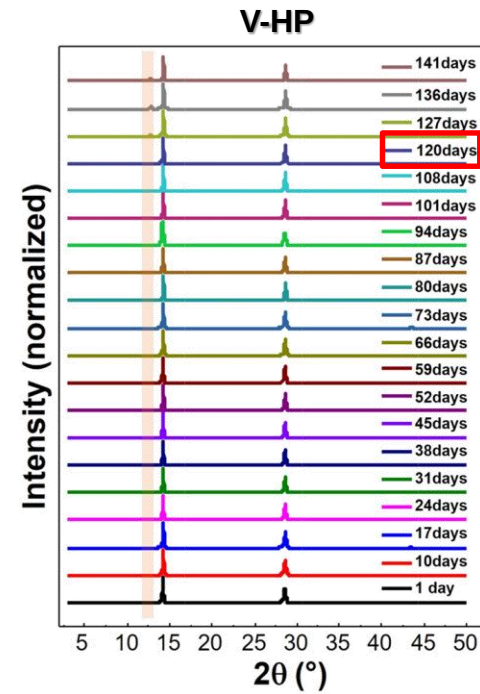
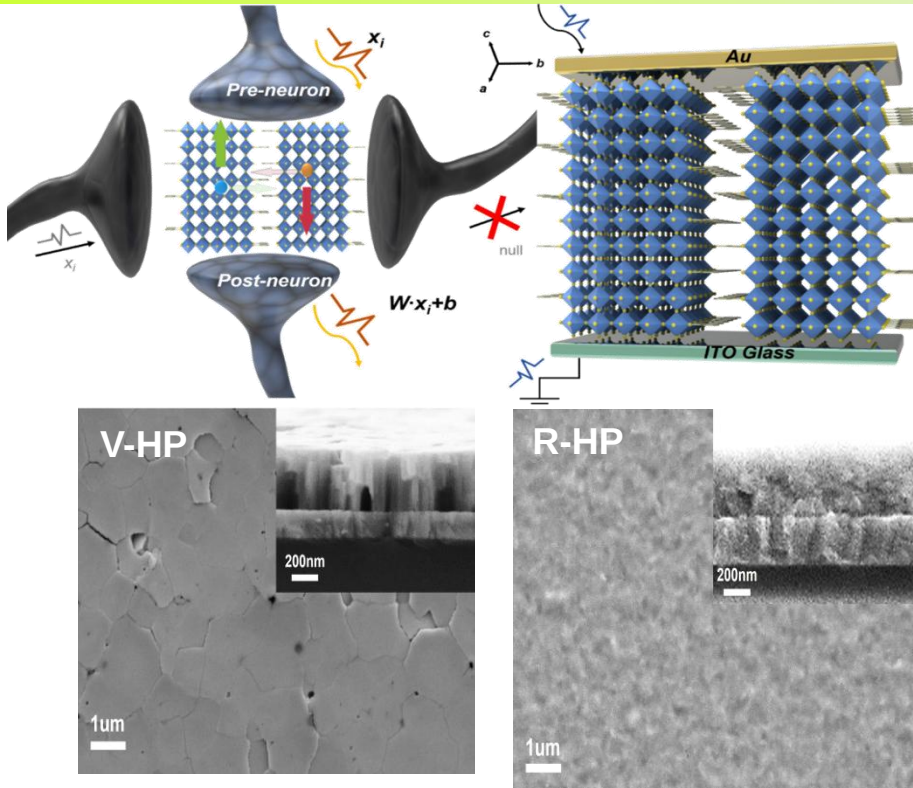
Polycrystalline nature of 3D halide perovskite hamper the reliable & controllable ionic charge migration

3D Perovskite (MAPbI₃)
2~3 days in ambient air condition

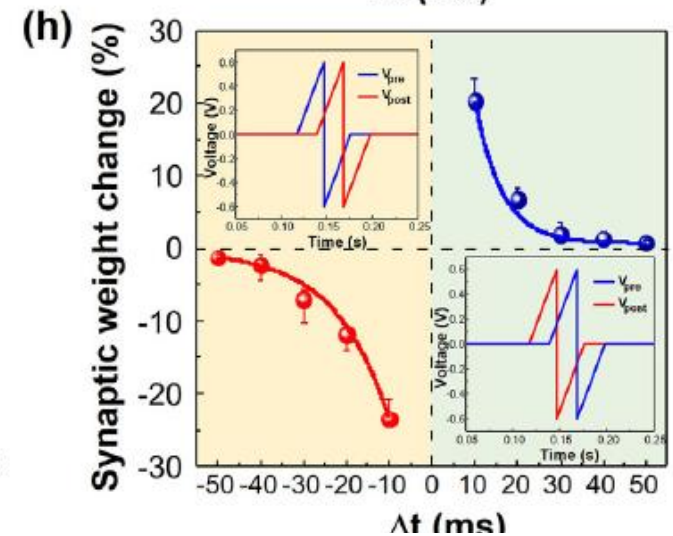
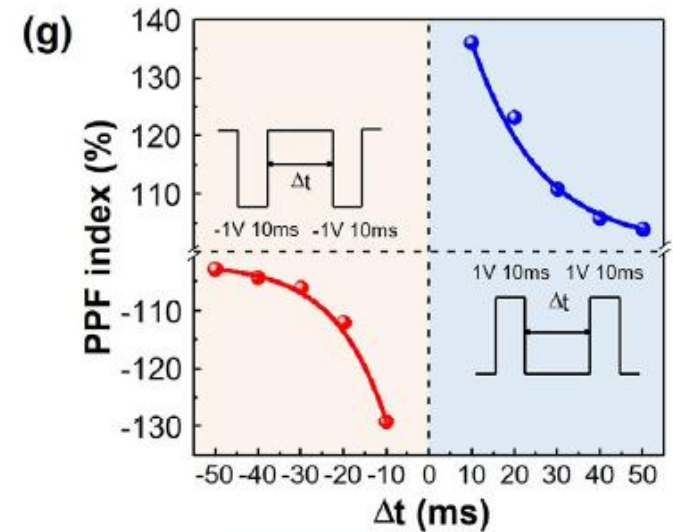
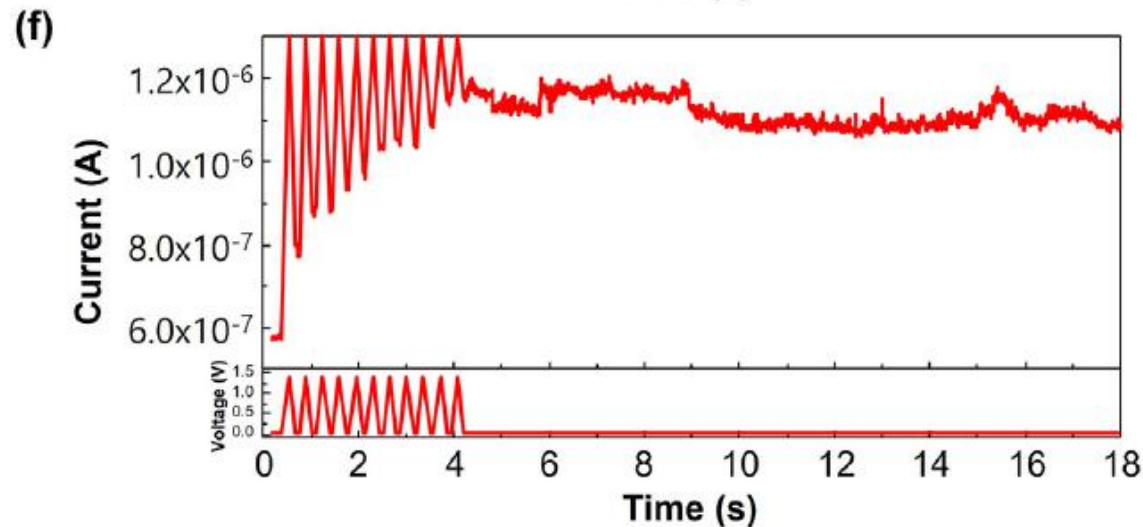
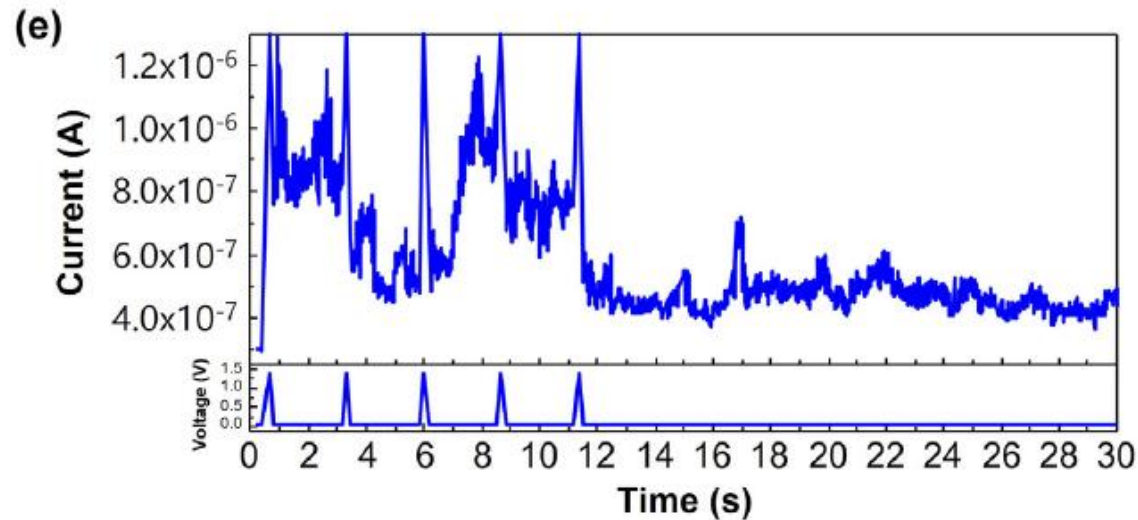


J. Phys. Chem. Lett. 2015, 6, 326–330

Vertically aligned two-dimensional halide perovskite on ITO



Synaptic characteristics of V-HP artificial synapse

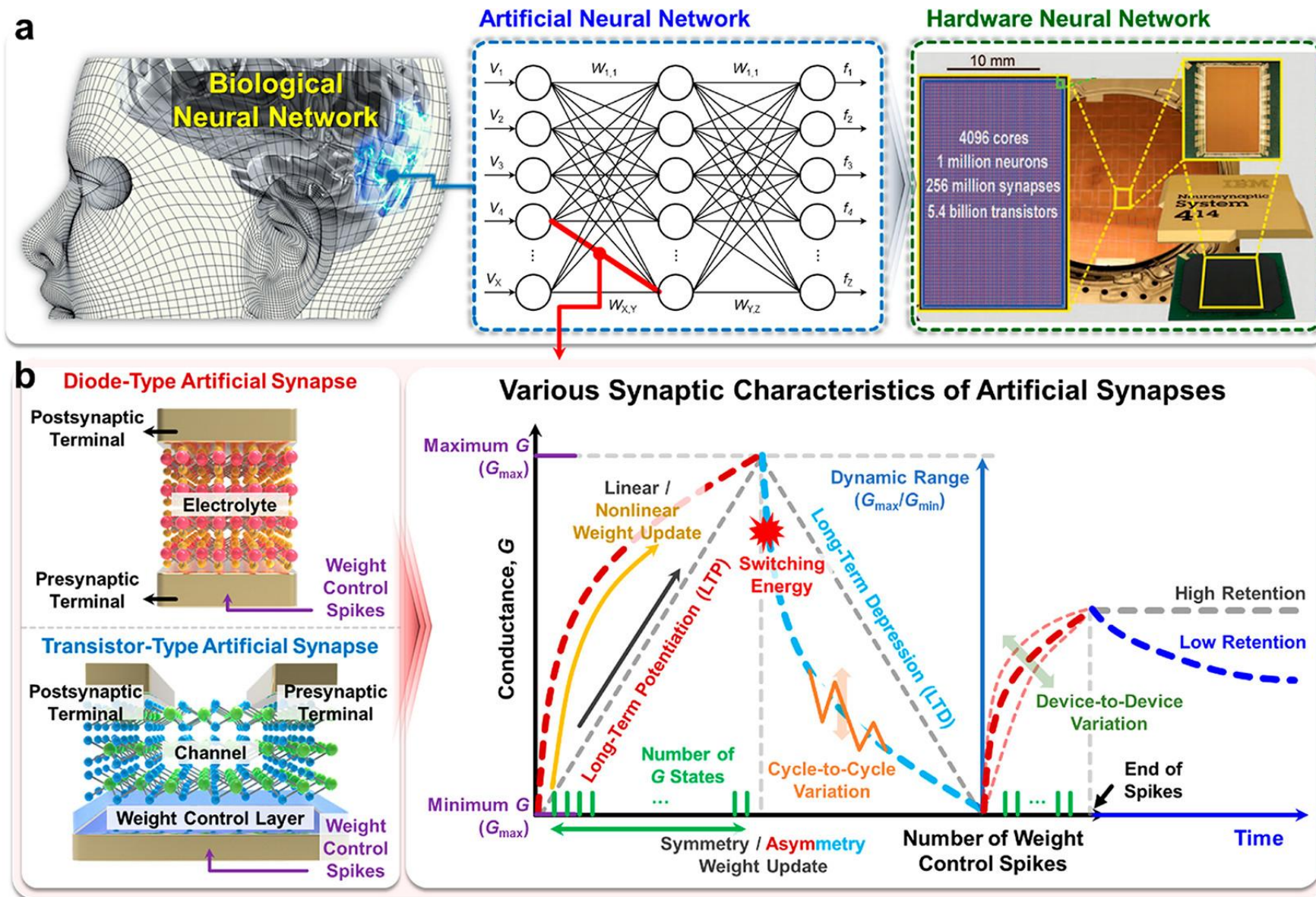


(e) Short-term plasticity (STP), and (f) long-term plasticity (LTP).

(g) Paired-pulse facilitation and depression (PPF & PPD). (h) Spike timing-dependent plasticity (STDP)



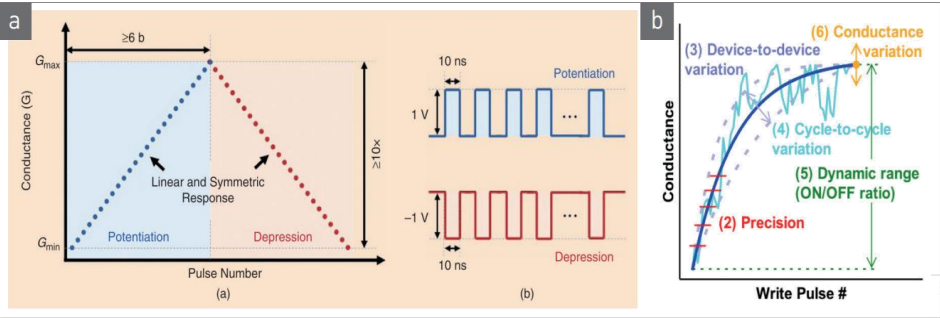
Linearity, symmetry, dynamic range, and retention



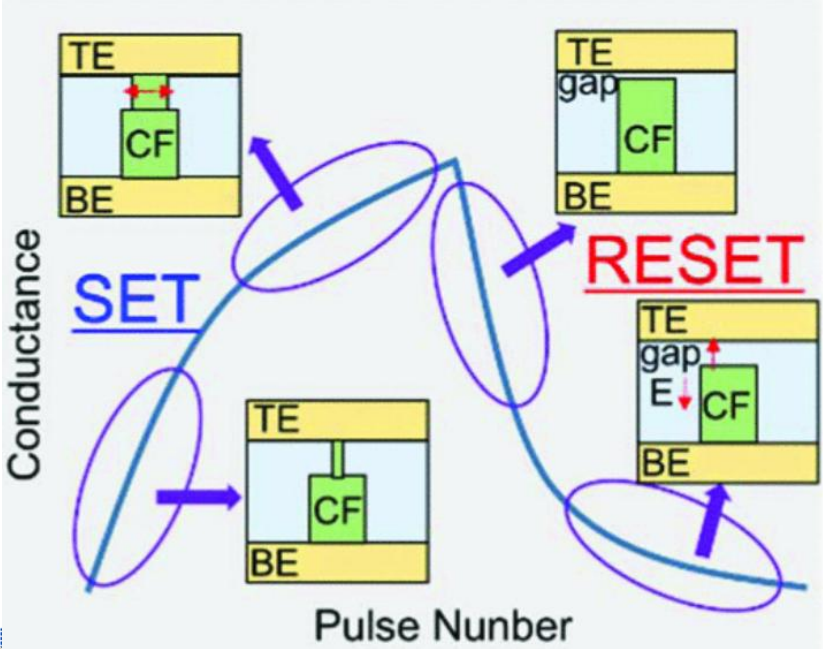
Conventional filamentary type memristors: nonlinear programming

► Synaptic weight updates with memristors

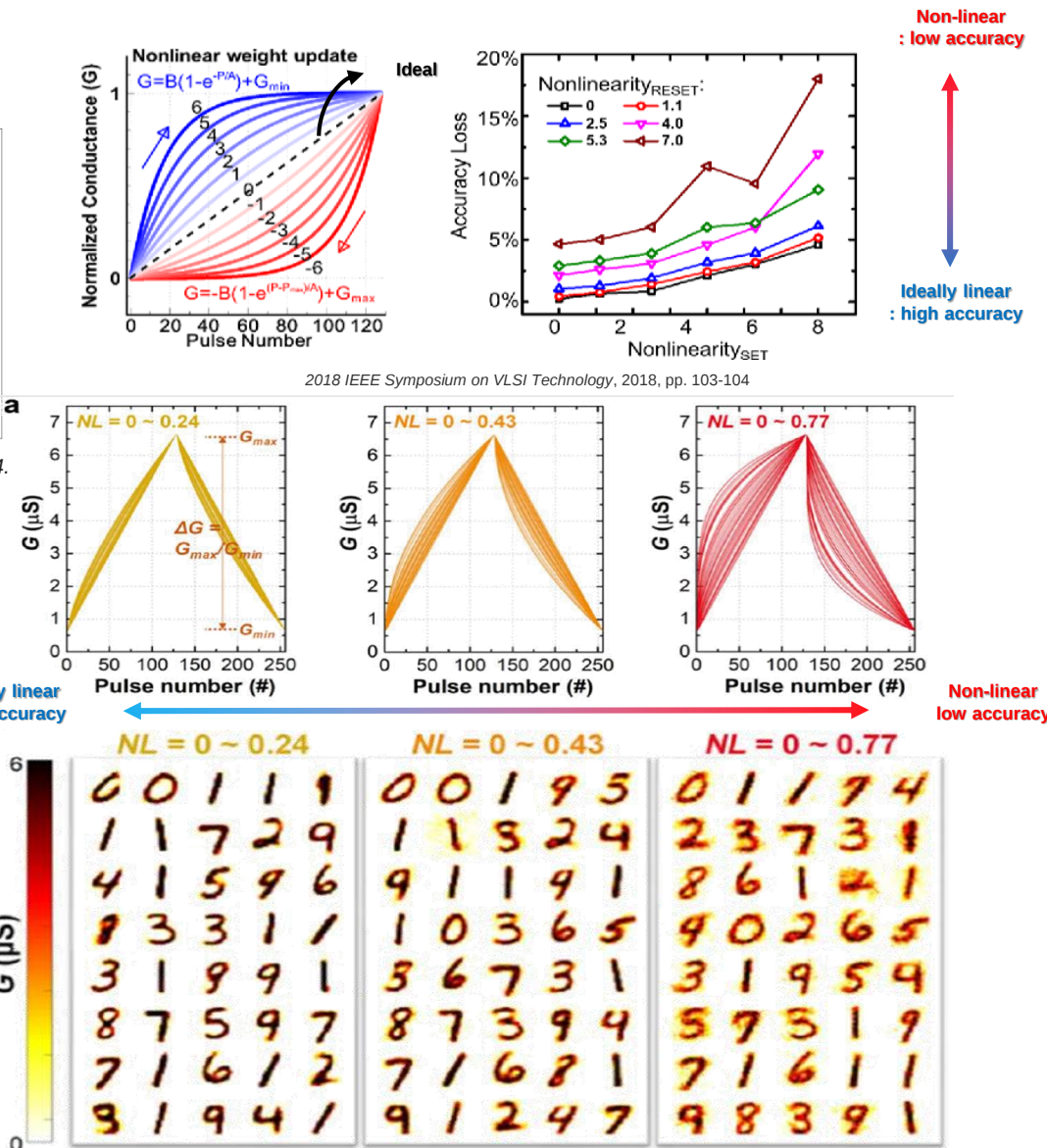
linearity & Symmetry

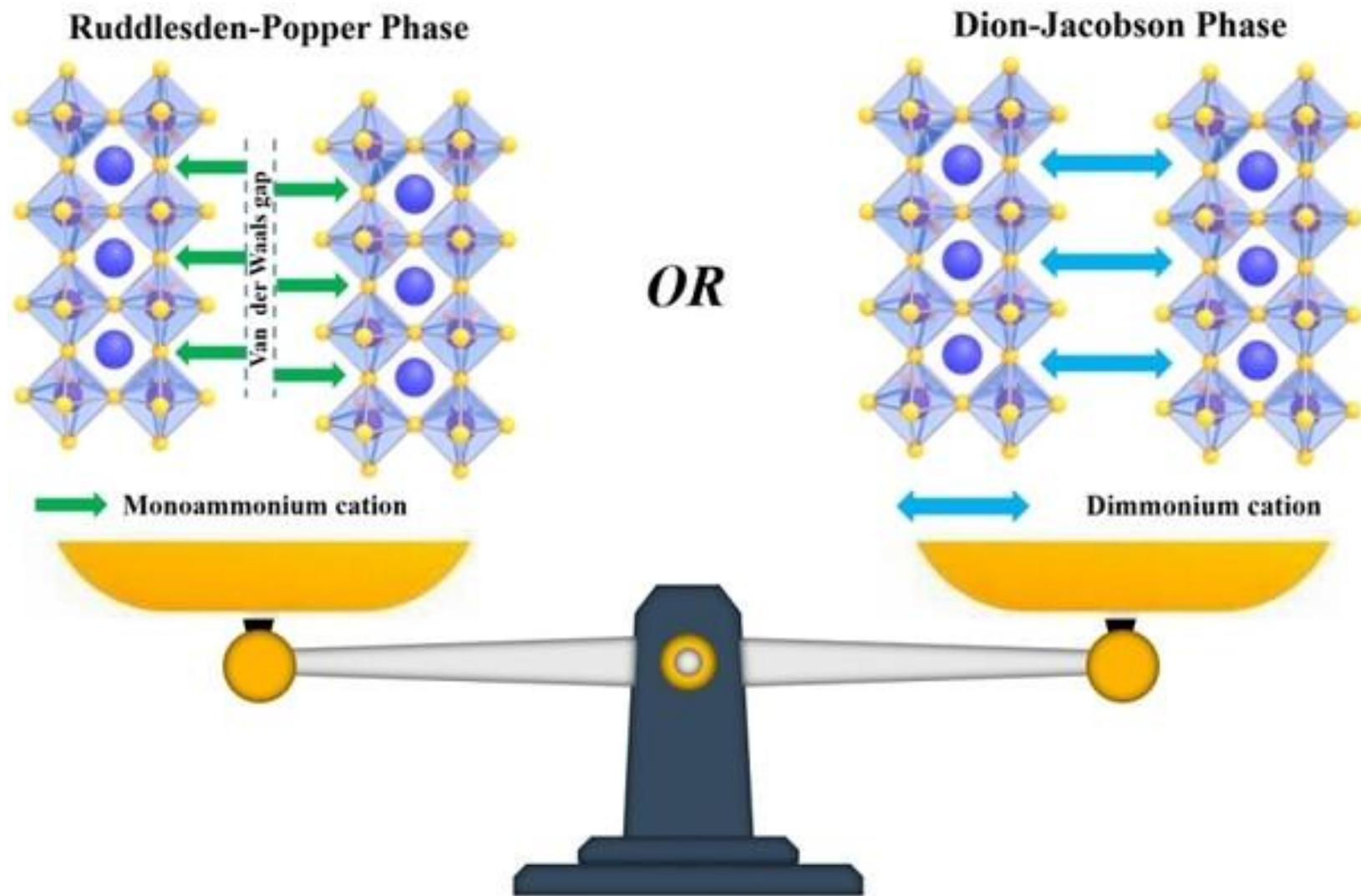


IEEE Nanotechnology magazine 12.3 (2018): 36-44.

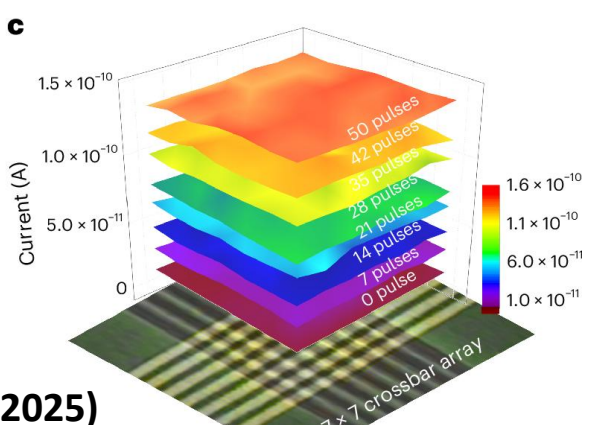
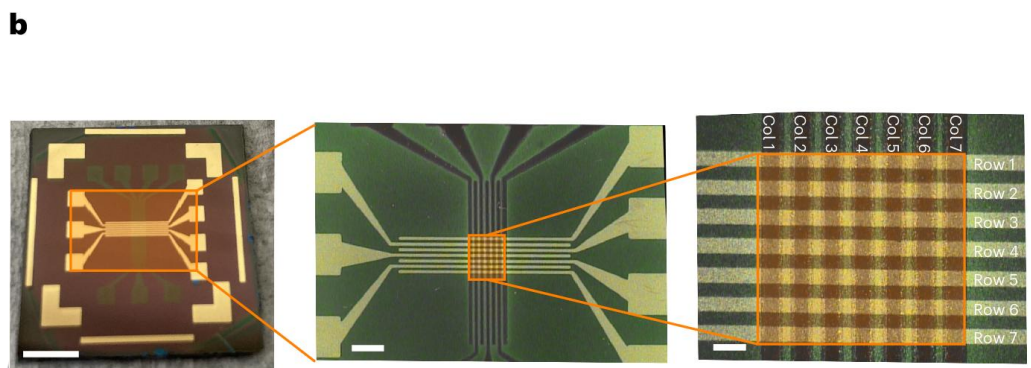
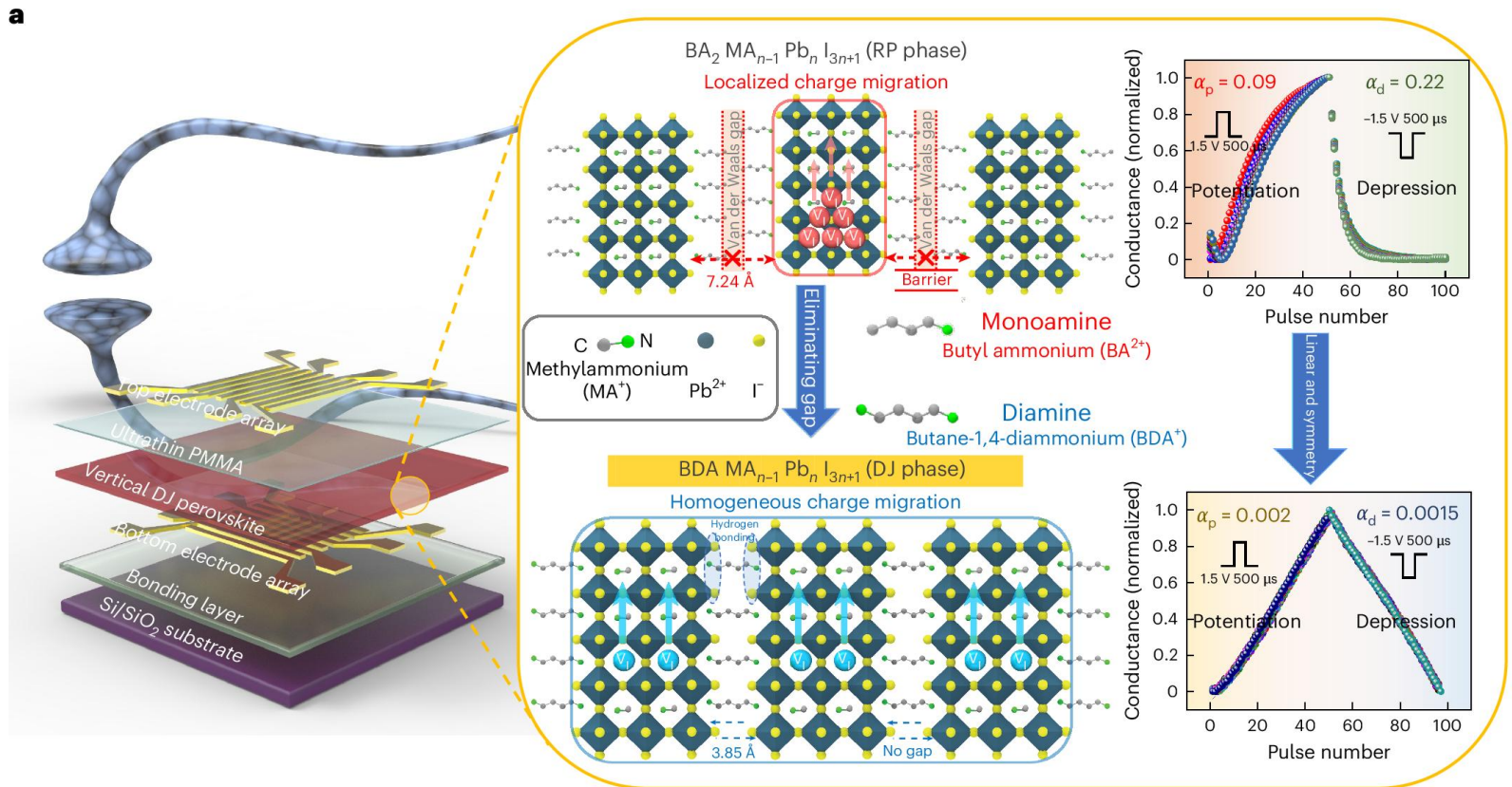


► AI accuracy depending on linearity

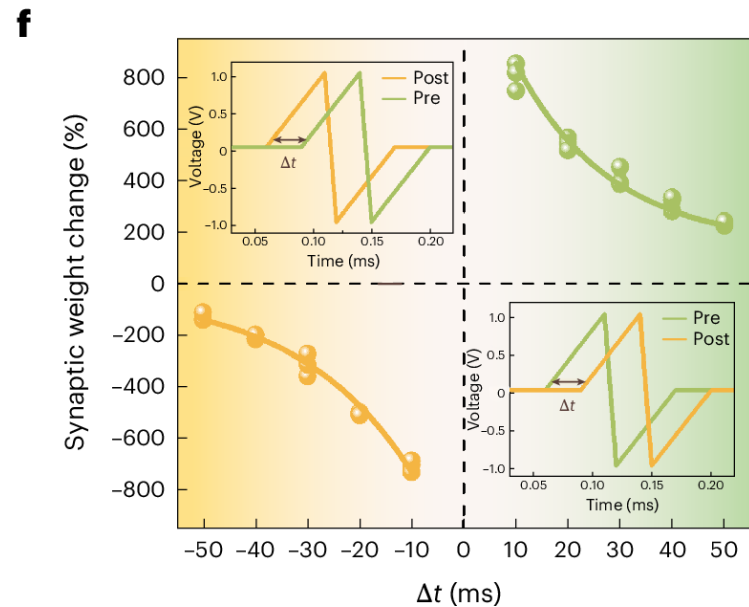
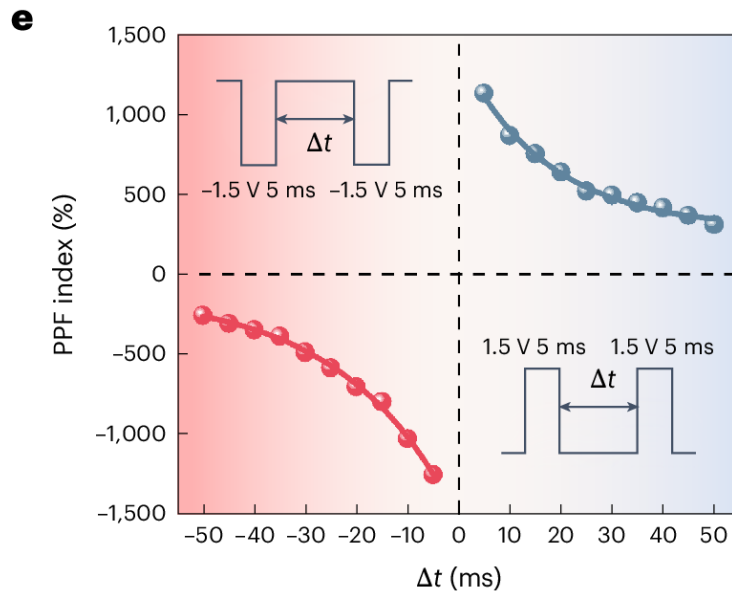
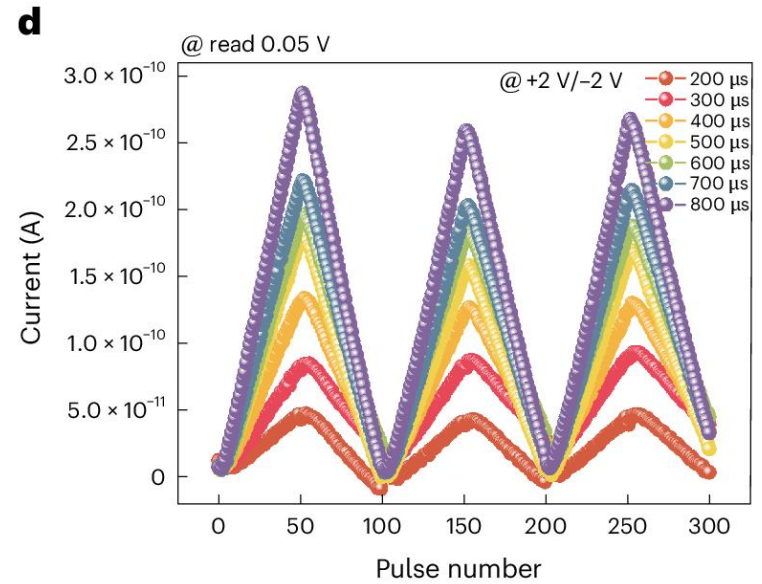
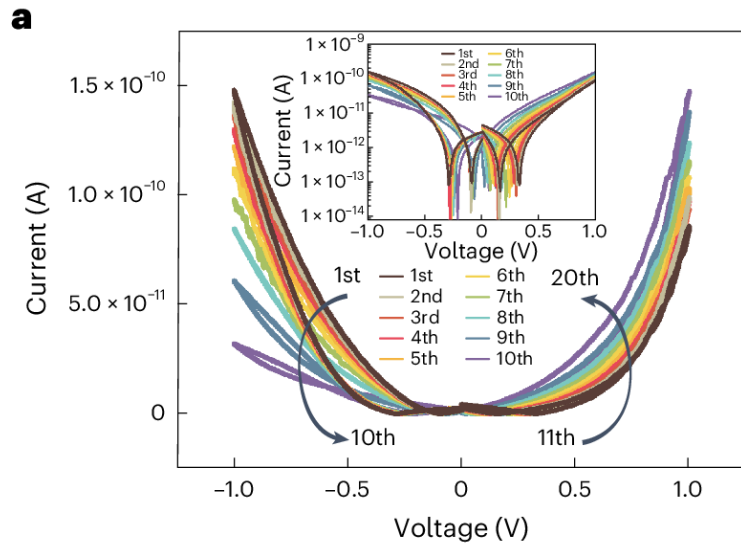




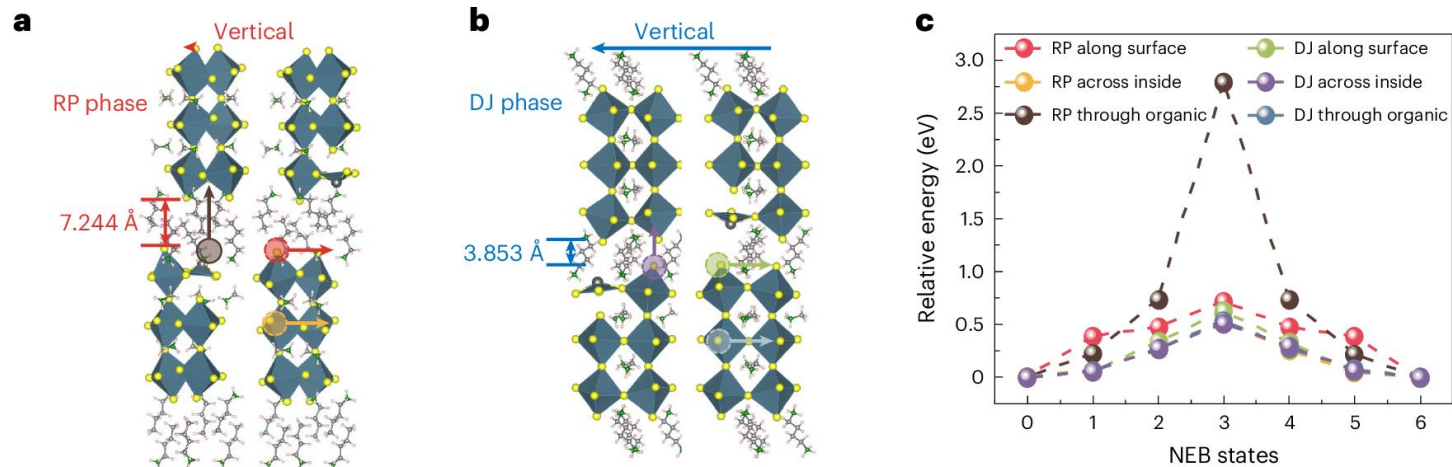
High linearity and symmetry in weight update using DJ phase



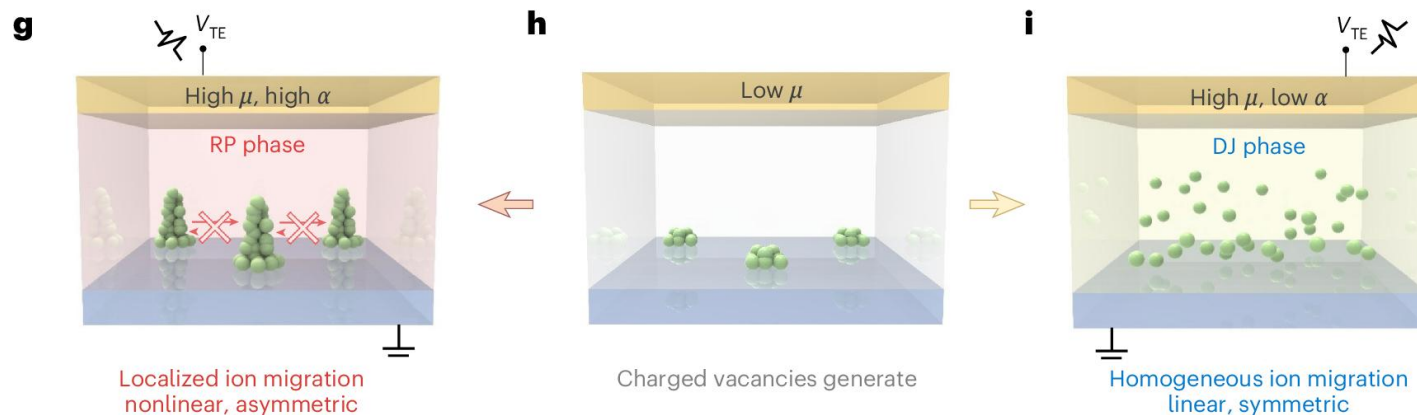
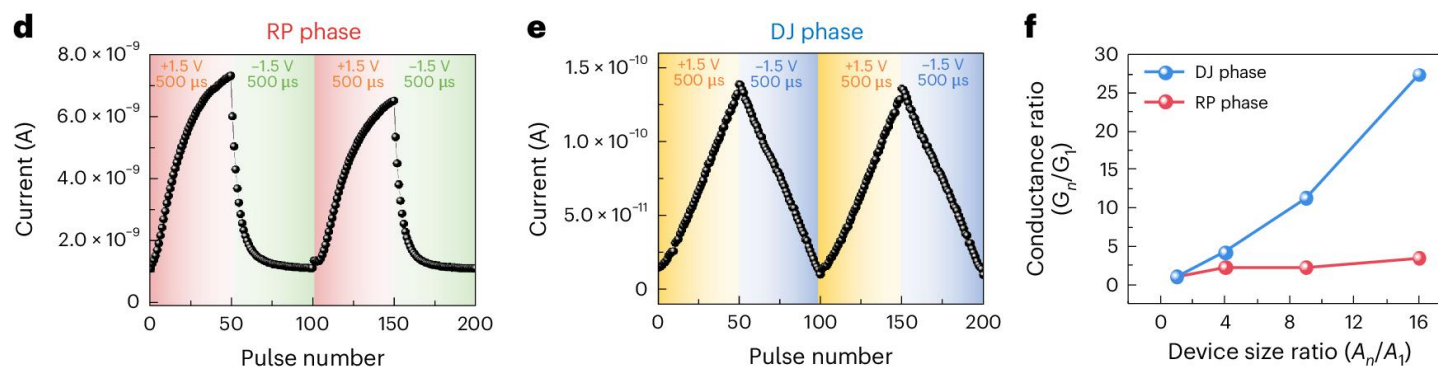
Synaptic plasticity of DJ-V-HP artificial synapses



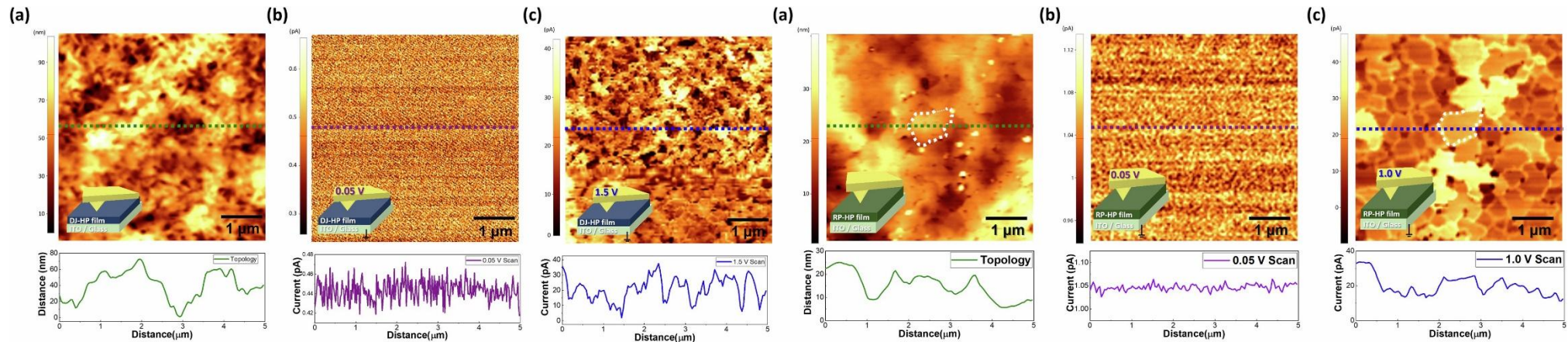
Disclosing resistive switching mechanisms in DJ- and RP-phase HPs



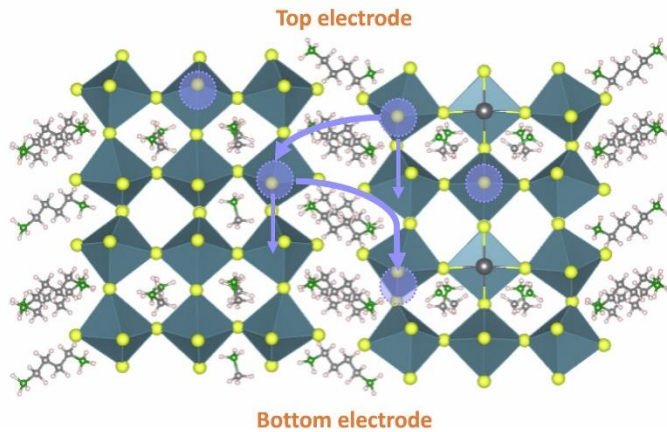
Prof. Donghwa Lee (POSTECH)



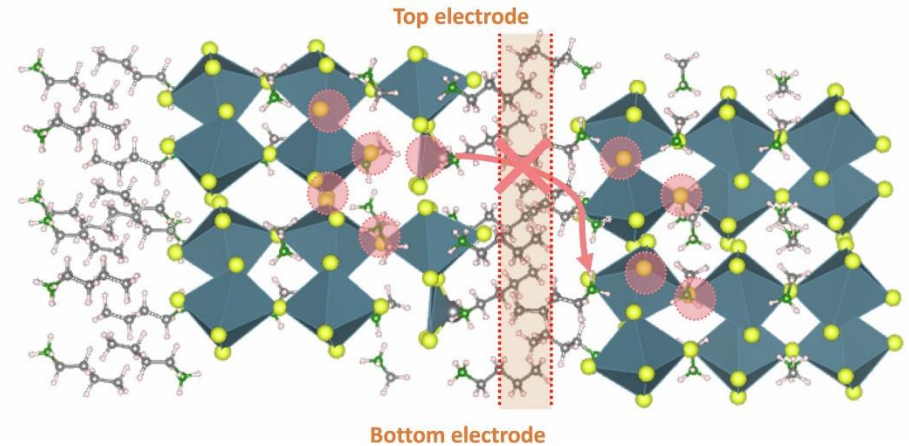
Sharp contrast in C-AFM images



(d) DJ-phase : No grain boundary barrier effect $\rightarrow$ homogenous ion migration

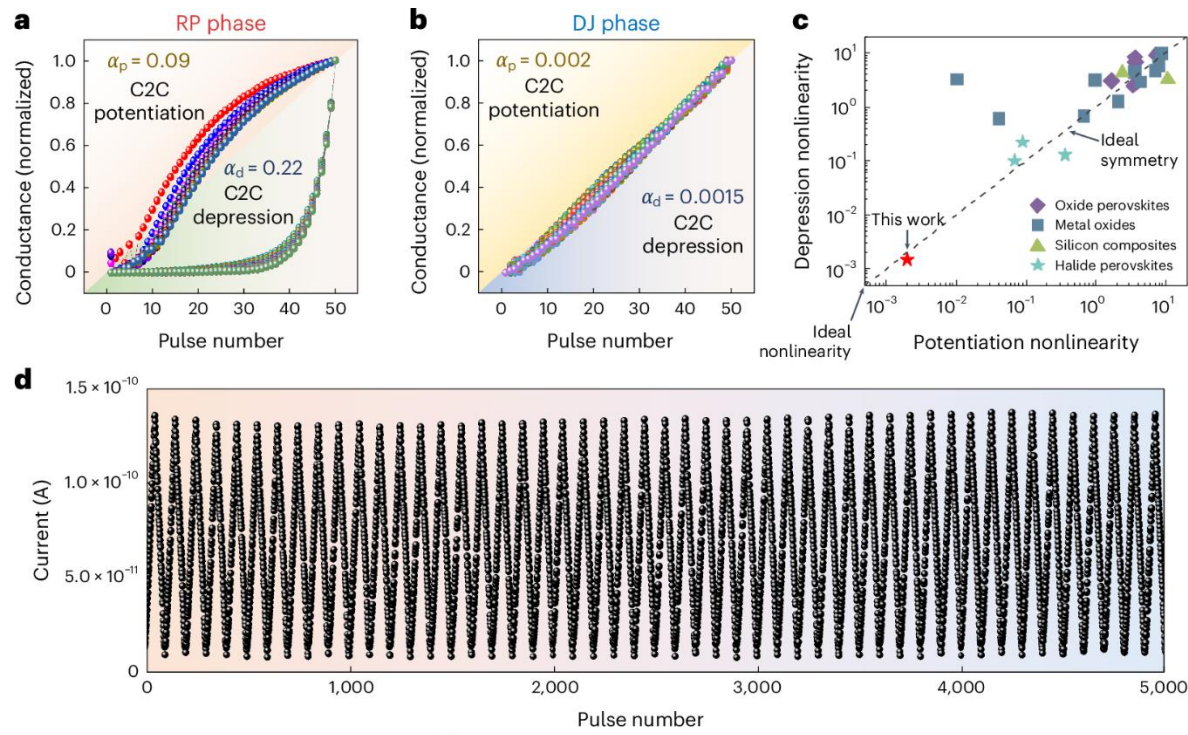


(d) RP-phase: Grain boundary barrier effect by Van der Waals gaps
 $\rightarrow$ Charged ions are bound to each grain

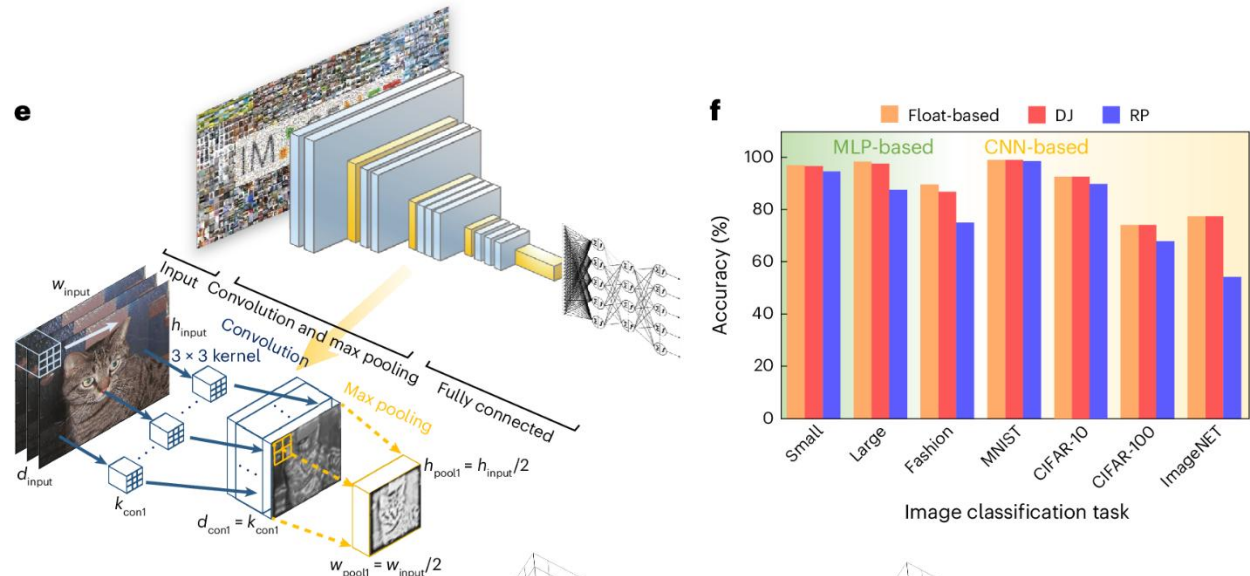


To further investigate the grain boundary barrier effect of charged ion migration, we performed conductive atomic force microscopy (C-AFM). The ion migration properties near the grain boundaries are a major determinant of whether homogeneous or localized ion migration is enabled.

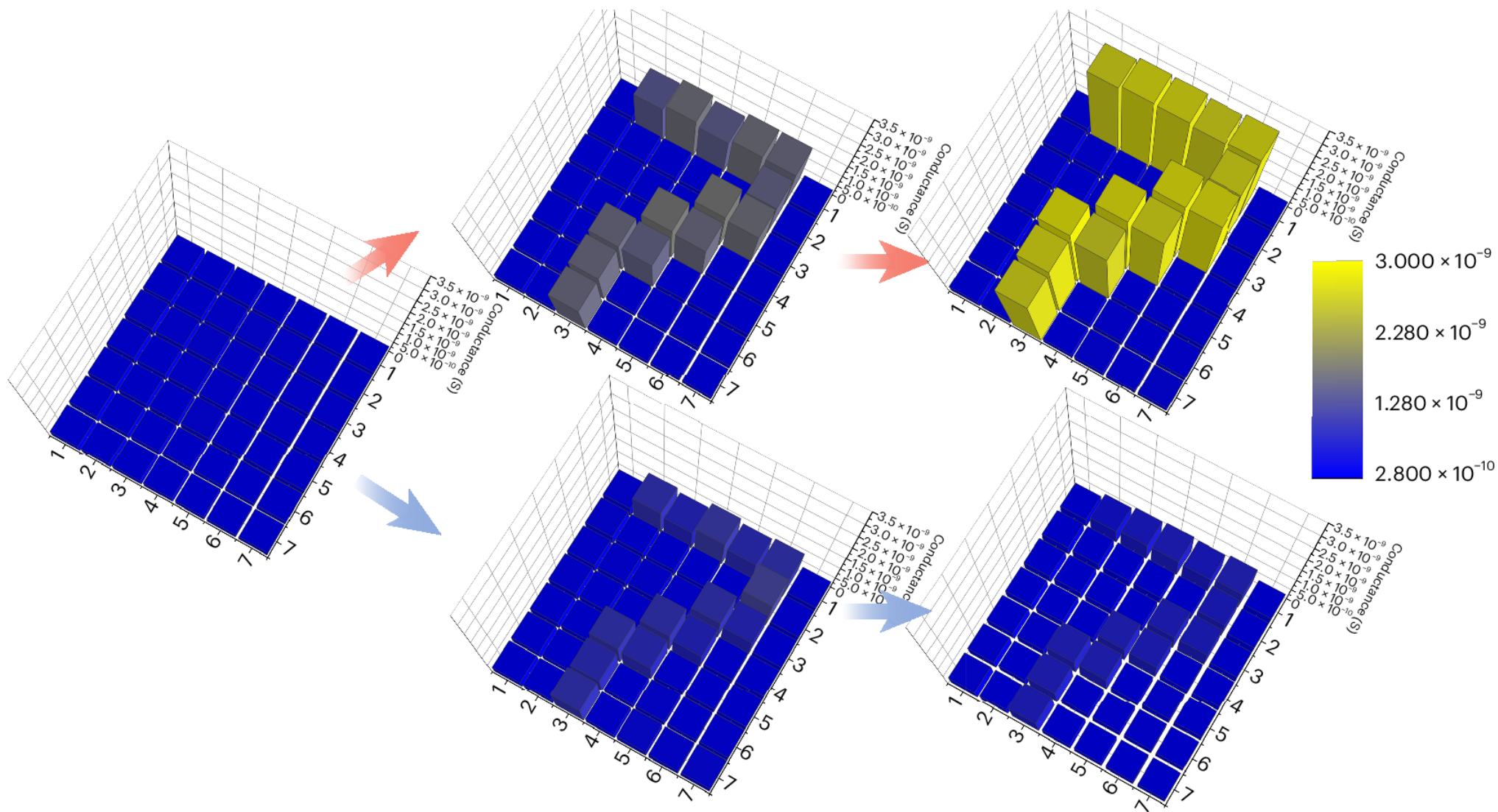
Neuromorphic crossbar array for AI acceleration



Prof. J. Joshua Yang (USC)

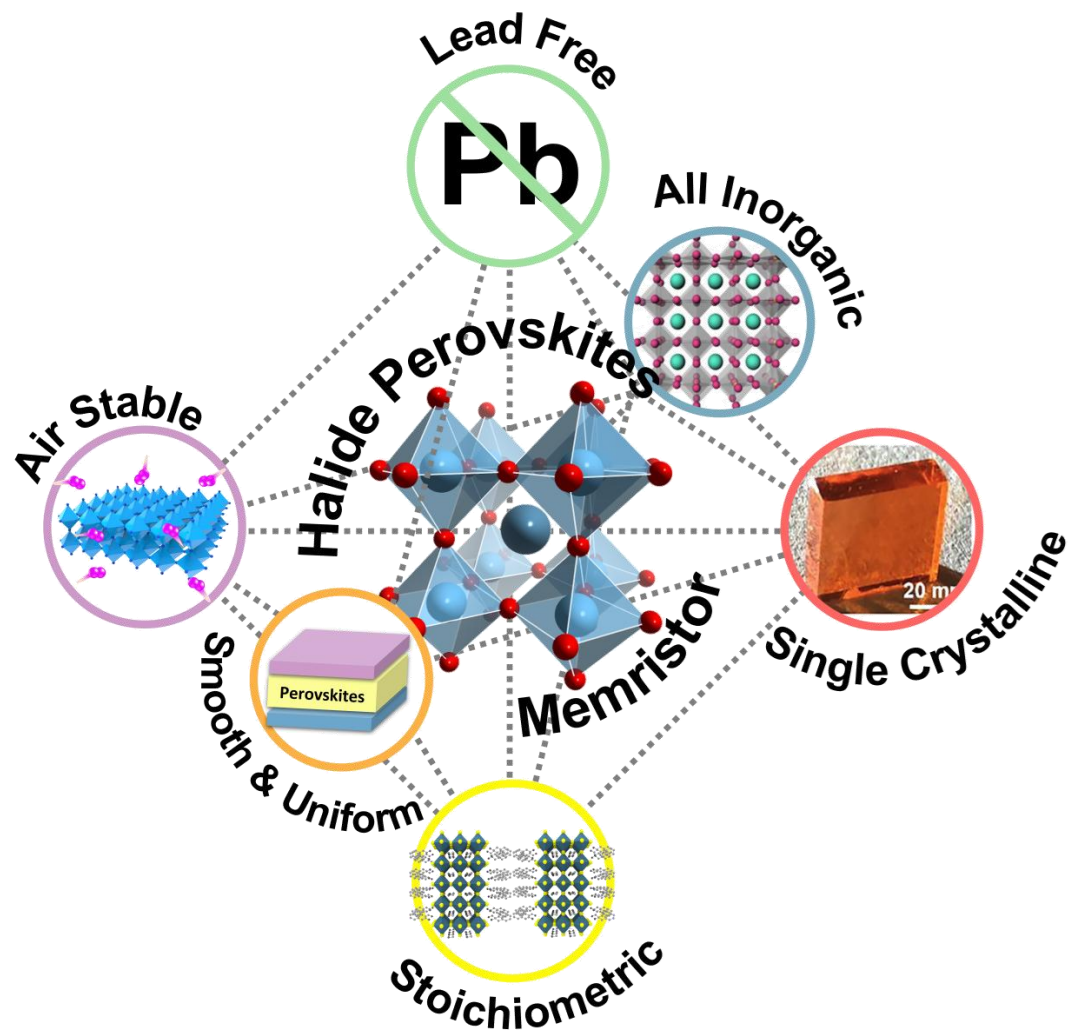


Programming 7×7 -pixel hand-written images

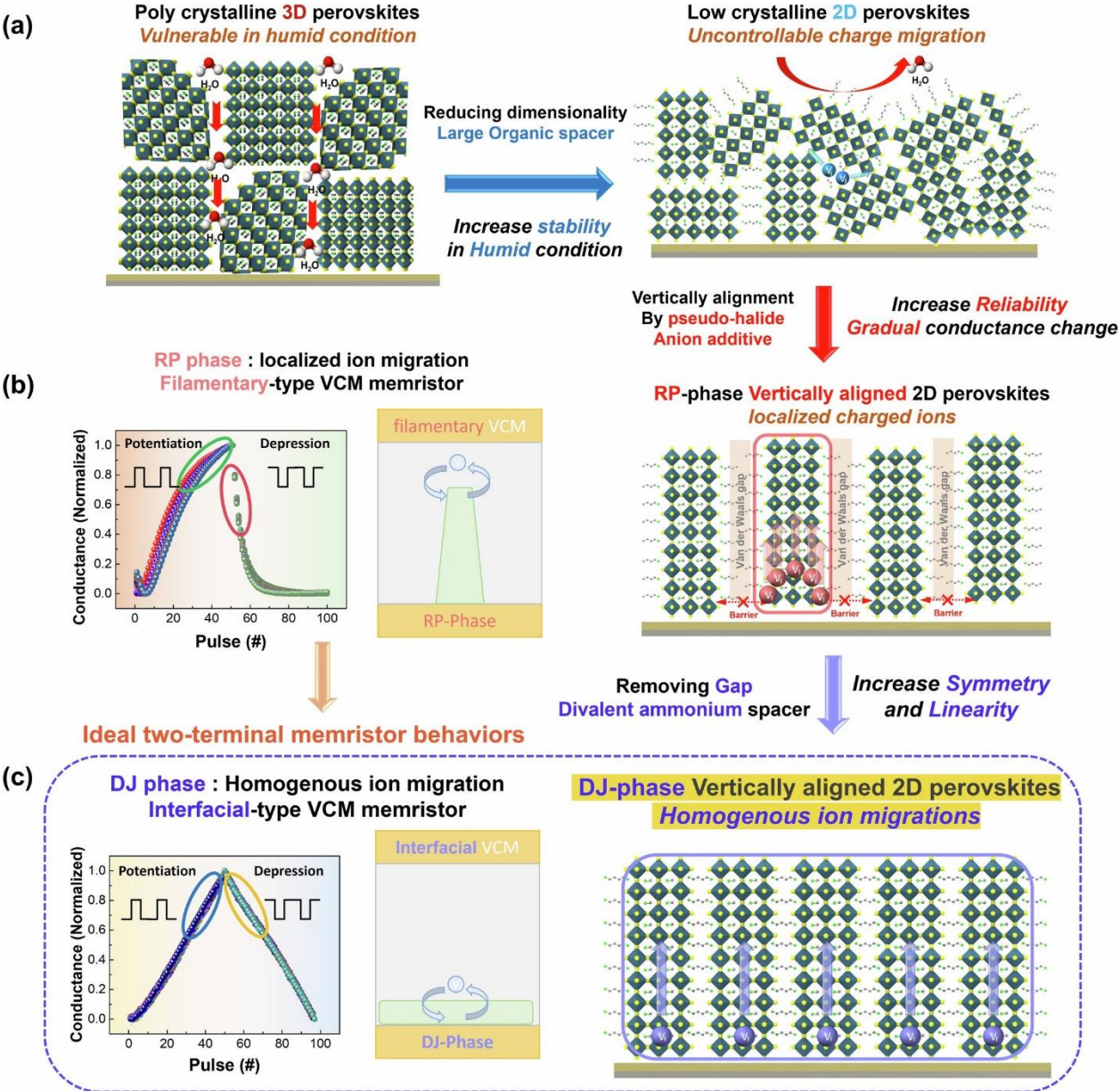


To demonstrate the synaptic weight storing capability, a 7×7 hand-written image was programmed into our DJ-V-HP crossbar array. We used long-term plasticity (LTP) and short-term plasticity (STP) characteristics to program the image into the crossbar

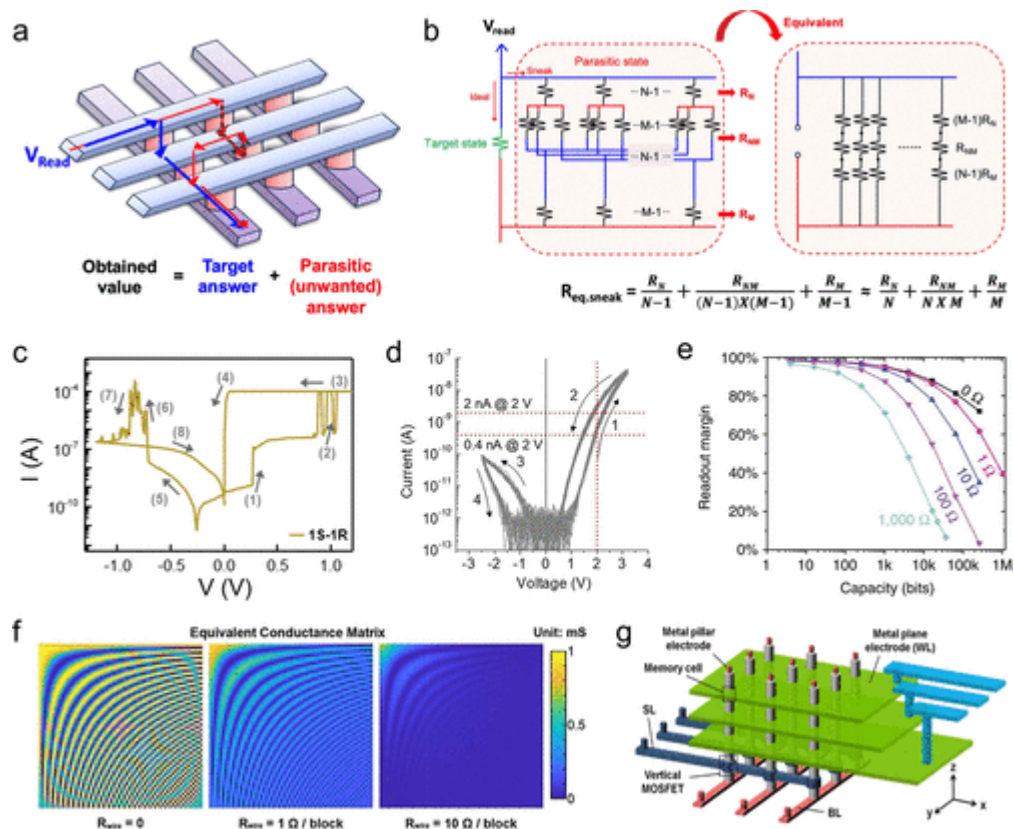
Challenges



Short summary



Issue in memristor array integration



Youngmin



Dr. Ji Hyun Baek

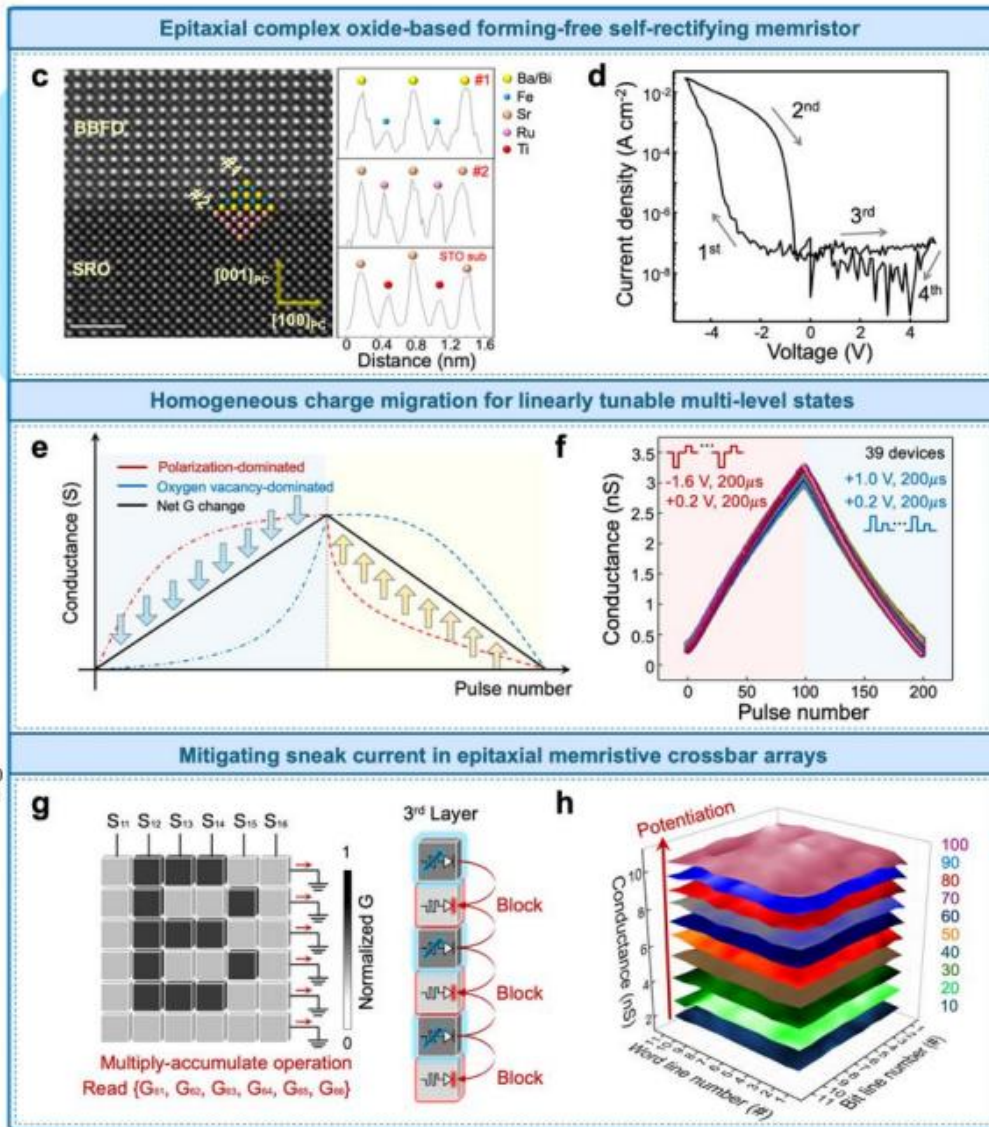
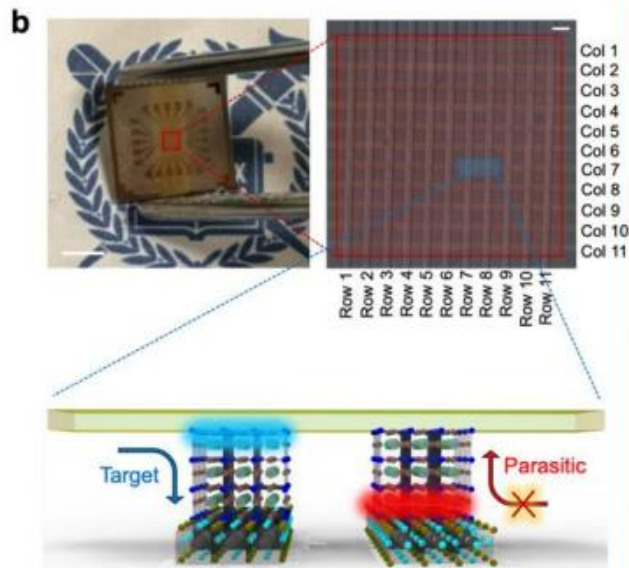
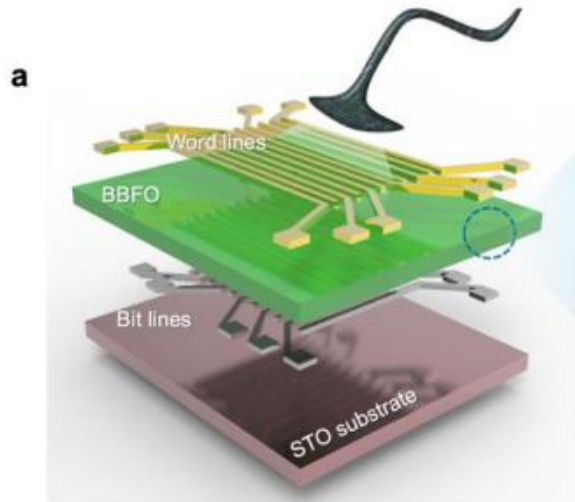


Dr. In Hyuk Im

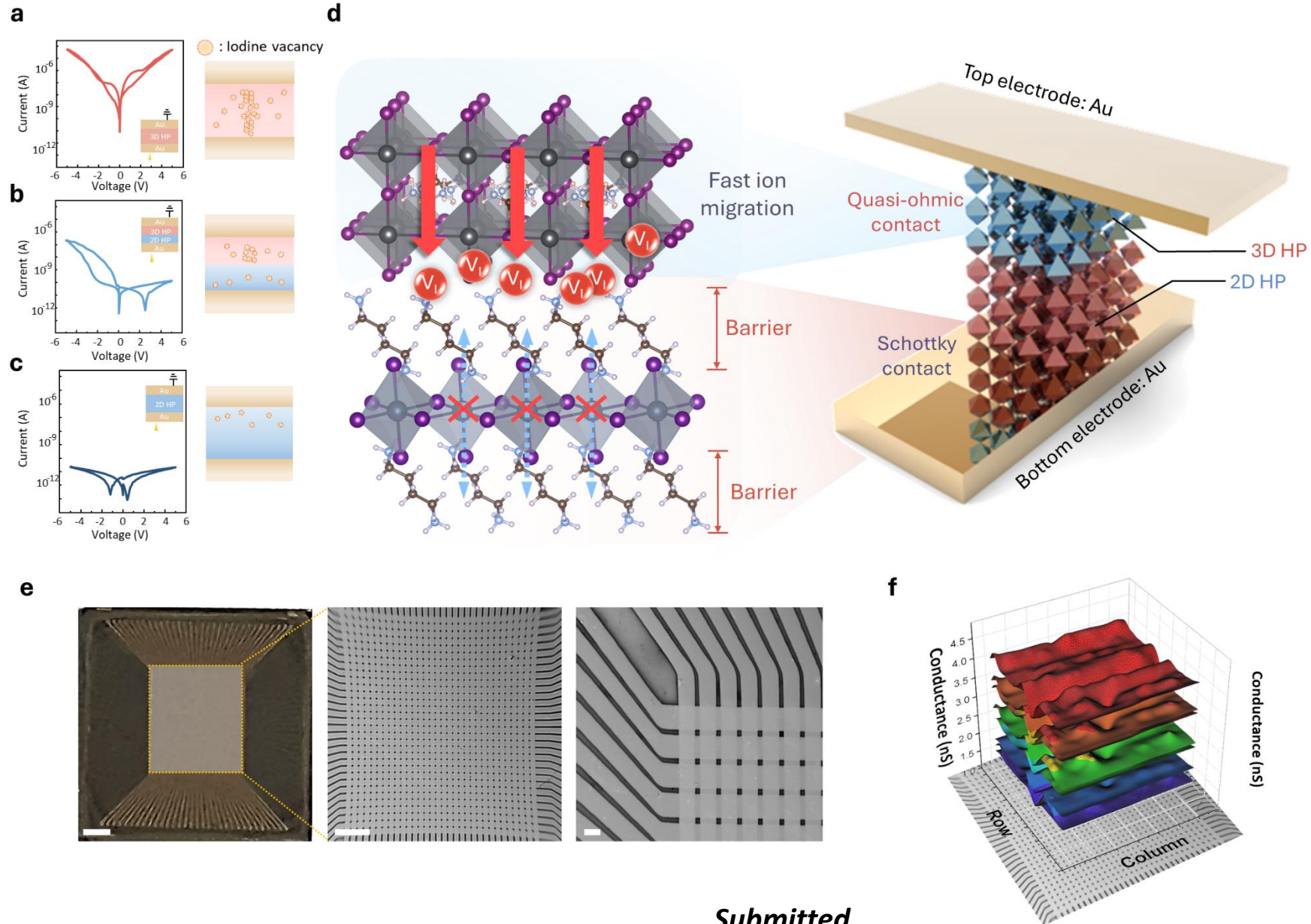
Figure 11. Issues in memristor array integration. (a) Schematic of the crossbar array with sneak current pathway during reading operation. (b) Equivalent transformed circuit diagram of the all current components during the operation of $M \times N$ crossbar array. Each sneak path is composed of serially connected $(M-1)R_N$, R_{MN} , and $(N-1)R_M$. (c) I - V characteristic of 1S-1R integrated component. (d) I - V characteristic of self-rectifying memristor. Reproduced with permission under a Creative Commons CC BY License from ref 244. Copyright 2021 Springer Nature. (e) The normalized readout margin according to the wire resistance, which is calculated by the circuit used in the SPICE simulation. Estimated crossbar array scale decreases with high wire resistance. Reproduced with permission under a Creative Commons CC BY License from ref 247. Copyright 2017 Springer Nature. (f) The color maps illustrating the effective conductance matrix in the memristor crossbar array with varying parasitic wire resistances. The left and upper sides of the map represent the conductance of the devices closer to the voltage source and bias ground, respectively. With increase in wire resistance, the device at the edge far from the source and ground receives reduced bias. Reproduced with permission under a Creative Commons Attribution License from ref 288. Copyright 2021 Wiley-VCH. (g) Illustration of the 3D crosspoint architecture based on the vertical memristor devices with the intersections of each pillar electrode and each plane electrode. Reproduced with permission from ref 289. Copyright 2013 American Chemical Society.

Programmable ferroelectric rectifier

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Self-rectifying 3D/2D HP memristors for crossbar array



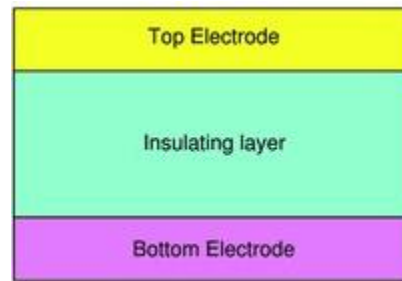
Hyeon Ji



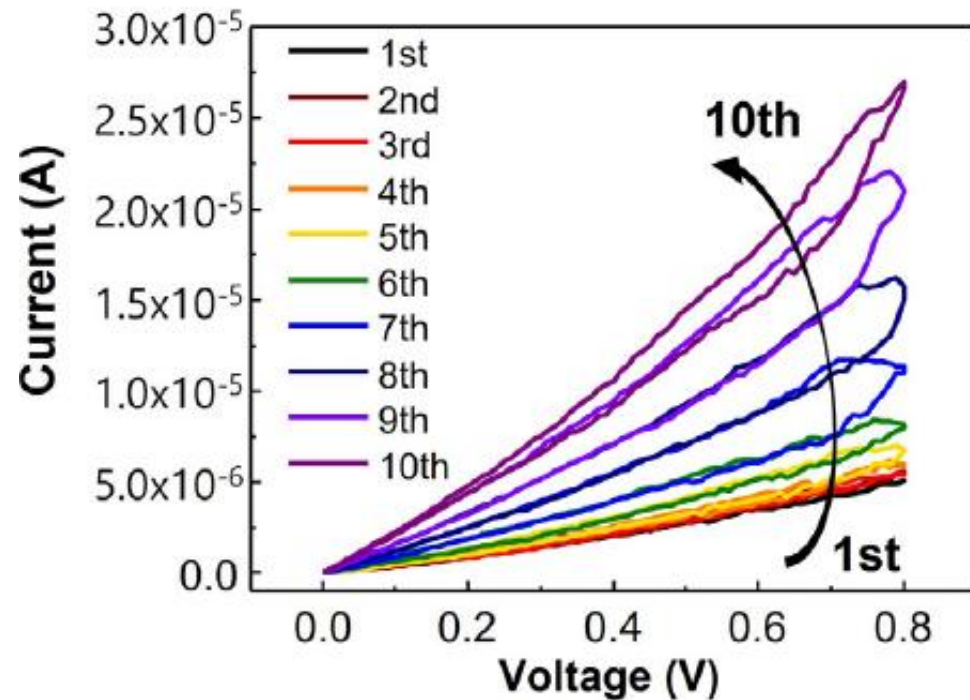
Short but clear remark

10^7 cm/s: electron in Si MOSFET

10^2 cm/s: action potential in neuron

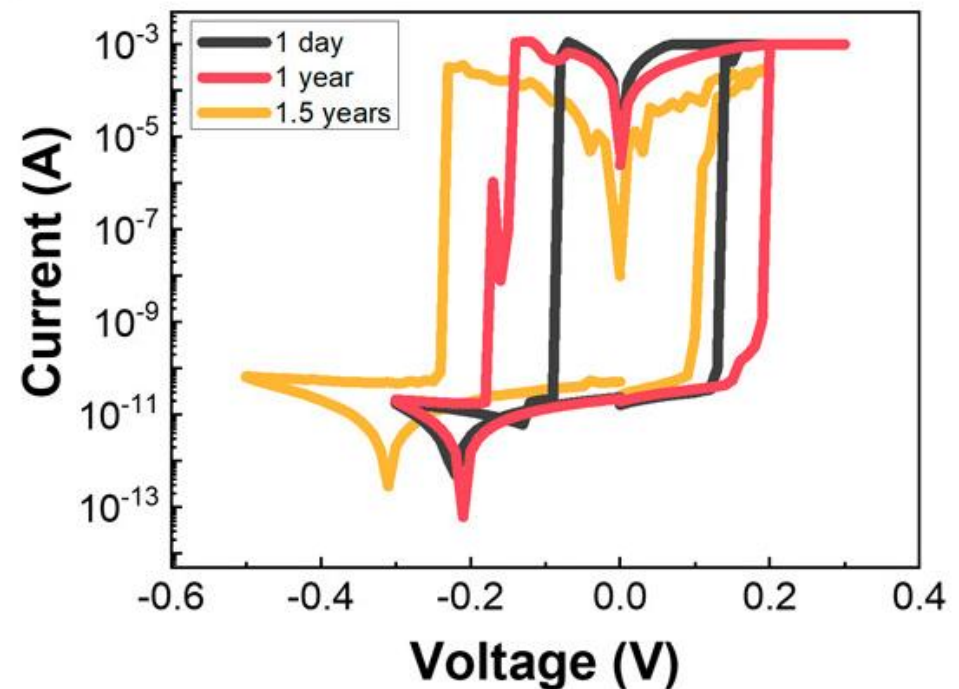


Slow and low-voltage sweep
without filament formation



Analog resistive switching
→ Neuromorphic computing

Fast and high voltage sweep
after filament formation



Digital resistive switching
→ Nonvolatile memory

Dr. Seung Ju Kim (SNU & USC)



Prof. J. Joshua Yang (USC)



Prof. Donghwa Lee (POSTECH)

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Thank you for your attention.

Q & A

